

Built-in Inrush Current Protection, 300mA High Speed LDO Voltage Regulator

■ GENERAL DESCRIPTION

The XC6223 series is a high speed LDO regulator that features high accurate, low noise, high ripple rejection, low dropout and low power consumption. The series consists of a voltage reference, an error amplifier, a driver transistor, a current limiter, a phase compensation circuit, a thermal shutdown circuit and an inrush current protection circuit.

The CE function enables the circuit to be in stand-by mode by inputting low level signal. In the stand-by mode, the series enables the electric charge at the output capacitor C_L to be discharged via the internal switch, and as a result the V_{OUT} pin quickly returns to the V_{SS} level. The output stabilization capacitor C_L is also compatible with low ESR ceramic capacitors.

The output voltage is selectable in 0.05V increments within the range of 1.2V to 4.0V which fixed by laser trimming technologies. The over current protection circuit and the thermal shutdown circuit are built-in. These two protection circuits will operate when the output current reaches current limit level or the junction temperature reaches temperature limit level.

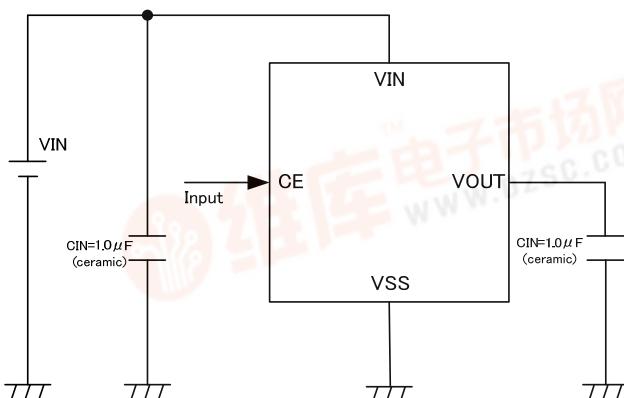
■ APPLICATIONS

- Digital still cameras
- Cell phones
- Portable games
- Camera modules
- IC recorders
- Portable media players
- Bluetooth
- Wireless LAN
- Terrestrial digital TV tuners
- Cordless phones

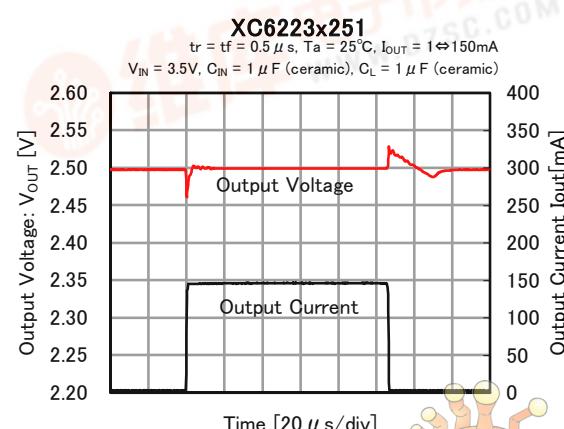
■ FEATURES

Maximum Output Current	: 300mA
Input Voltage Range	: 1.6~5.5V
Output Voltages	: 2.0~4.0V (Accuracy $\pm 1\%$) 1.2~1.95V (Accuracy $\pm 20mV$) 0.05V increments
Dropout Voltage	: 200mV@ $I_{OUT}=300mA$ ($V_{OUT}=3.0V$)
Low Power Consumption	: 100 μA
Stand-by Current	: 0.1 μA
High Ripple Rejection	: 80dB@ $f=1kHz$
Protection Circuits	: Current Limit(400mA) Short Circuit Protection Over Heat Protection Inrush Current Protection
Low ESR Capacitors	: $C_{IN}=1.0 \mu F$, $C_L=1.0 \mu F$
CE Function	: Active High C_L High Speed Discharge
Small Packages	: USPQ-4B03 USP-4 SSOT-24 SOT-25 SOT-89-5
Environmentally Friendly	: EU RoHS Compliant, Pb Free

■ TYPICAL APPLICATION CIRCUIT



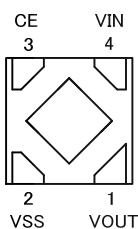
■ TYPICAL PERFORMANCE CHARACTERISTICS



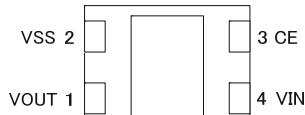
XC6223 Series

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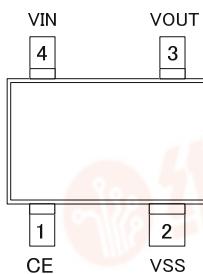
■PIN CONFIGURATION



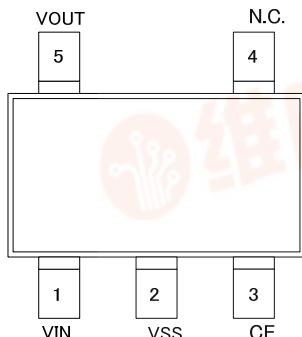
USPQ-4B03
(BOTTOM VIEW)



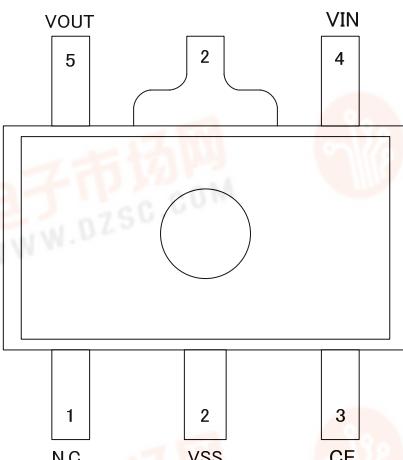
USP-4
(BOTTOM VIEW)



SSOT-24
(TOP VIEW)



SOT-25
(TOP VIEW)



SOT-89-5
(TOP VIEW)

*The dissipation pad for the USPQ-4B03, USP-4 packages should be solder-plated in reference mount pattern and metal masking so as to enhance mounting strength and heat release. If the pad needs to be connected to other pins, it should be connected to the V_{SS} (No. 2) pin.

■PIN ASSIGNMENT

PIN NUMBER					PIN NAME	FUNCTIONS
USPQ-4B03	USP-4	SSOT-24	SOT-25	SOT-89-5		
4	4	4	1	4	V _{IN}	Power Input
1	1	3	5	5	V _{OUT}	Output
2	2	2	2	2	V _{SS}	Ground
3	3	1	3	3	CE	ON/OFF Control
-	-	-	4	1	NC	No Connection

■PIN FUNCTION ASSIGNMENT

CE Ethics Condition	IC Operation State ON/OFF
H	Operation ON
L	Operation OFF(Stand-by)
OPEN	*

* Undefined state in XC6223 A/B/E/F. On the other hand, Operation OFF states in XC6223C/D/G/H because that an internal pull-down resister maintains the CE pin voltage to be low.

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■ PRODUCT CLASSIFICATION

● Ordering Information

XC6223①②③④⑤⑥-⑦^(*)1)

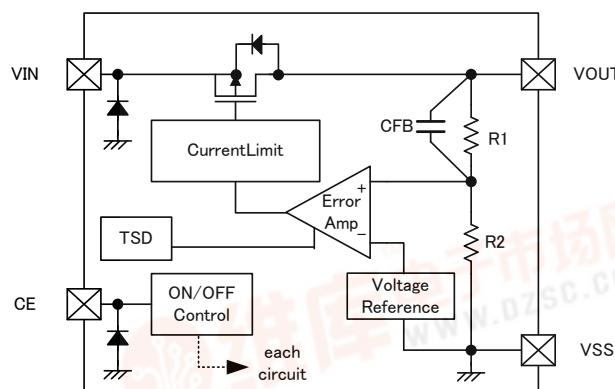
DESIGNATOR	ITEM	SYMBOL	DESCRIPTION		
①	Type of Regulator (CE active high)		Inrush Current Protection	CE Pull-Down Resistor	C _L Discharge
		A	NO	NO	NO
		B	NO	NO	YES
		C	NO	YES (1MΩ, TYP built-in)	NO
		D	NO	YES (1MΩ, TYP built-in)	YES
		E	YES	NO	NO
		F	YES	NO	YES
		G	YES	YES (1MΩ, TYP built-in)	NO
		H (The Recommended Type)	YES	YES (1MΩ, TYP built-in)	YES
②③	Output Voltage	12~40	ex.) 2.80V → ②=2, ③=8, ④=please see down below.		
④	Output Voltage (2 nd decimal place)	1	ex.) 2.80V → ④=1		
		B	ex.) 2.85V → ④=B		
⑤⑥-⑦ ^(*)1)	Packages (Order Unit)	9R-G	USPQ-4B03 (5,000/Reel)		
		GR-G	USP-4 (3,000/Reel)		
		NR-G	SSOT-24 (3,000/Reel)		
		MR-G	SOT-25 (3,000/Reel)		
		PR-G	SOT-89-5 (3,000/Reel)		

^(*)1) The “-G” suffix indicates that the products are Halogen and Antimony free as well as being fully RoHS compliant.

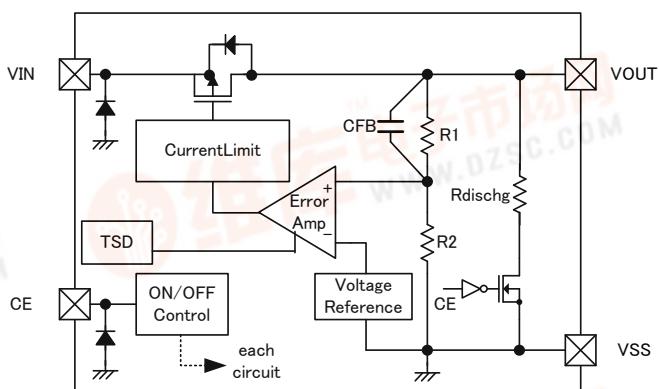
XC6223 Series

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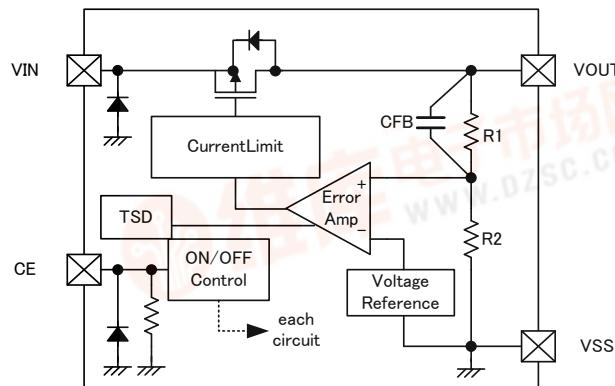
■ BLOCK DIAGRAMS



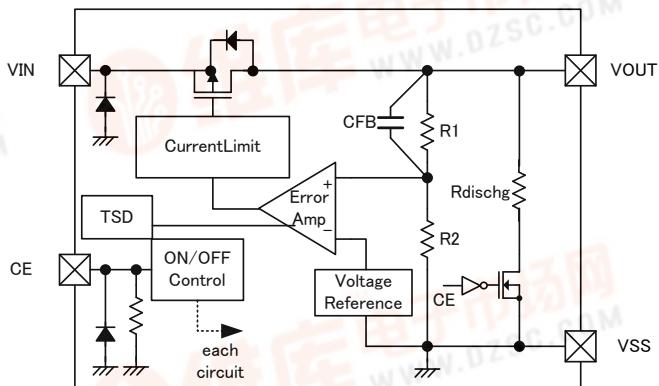
XC6223Aseries



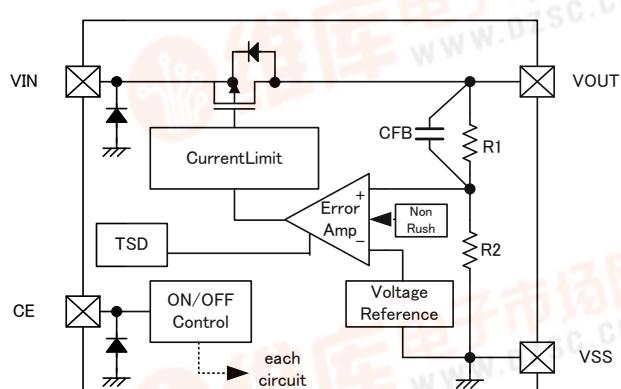
XC6223Bseries



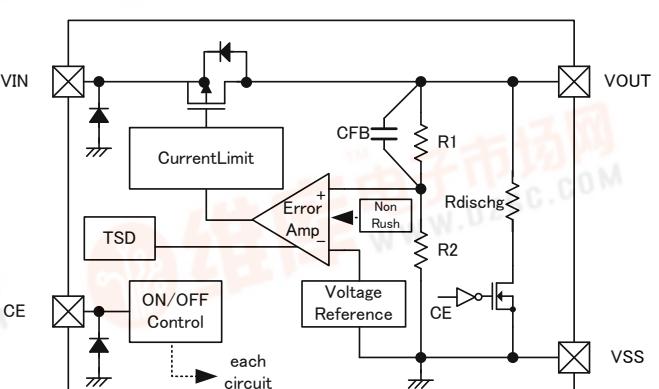
XC6223Cseries



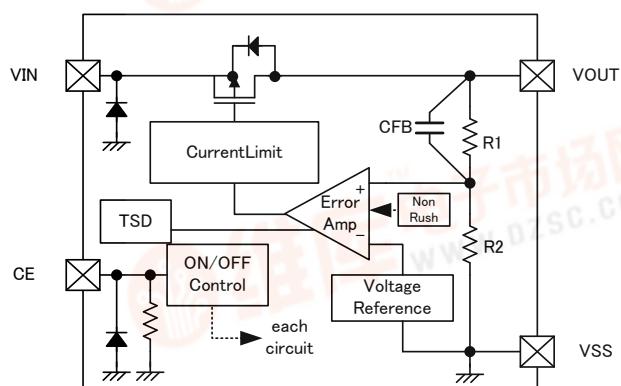
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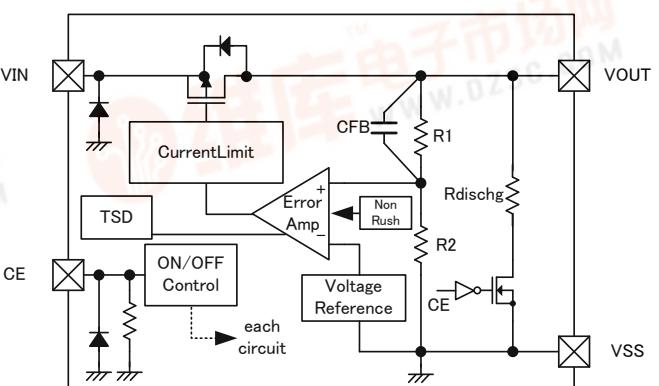
XC6223Eseries



XC6223Fseries



XC6223Gseries



XC6223Hseries

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■ ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	RATINGS	UNITS
Input Voltage	V _{IN}	V _{SS} -0.3~+7.0	V
Output Current	I _{OUT}	500 ^(*)1)	mA
Output Voltage	V _{OUT}	V _{SS} -0.3~V _{IN} +0.3	V
CE Input Voltage	V _{CE}	V _{SS} -0.3~+7.0	V
Power Dissipation	USPQ-4B03	100	mW
		550 (PCB mounted) ^(*)2)	
	USP-4	120	
		1000 (PCB mounted) ^(*)2)	
	SSOT-24	150	
		500 (PCB mounted) ^(*)2)	
	SOT-25	250	
		600 (PCB mounted) ^(*)2)	
	SOT-89-5	500	
		1300 (PCB mounted) ^(*)2)	
Operating Temperature Range	Topr	-40~+85	°C
Storage Temperature Range	Tstg	-55~+125	°C

(*1) : I_{OUT}≤Pd / (V_{IN}-V_{OUT})

(*2) : The power dissipation figure shown is PCB mounted. Please refer to page 26~29 for details.

XC6223 Series

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ELECTRICAL CHARACTERISTICS

● XC6223A/B/C/D/E/F/G/H Series

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUITS
Output Voltage	V _{OUT(E)} (*1)	V _{OUT(T)} ≥2.0V, V _{CE} =V _{IN} , I _{OUT} =10mA	V _{OUT(T)} ×0.99 (*2)	V _{OUT(T)} (*2)	V _{OUT(T)} ×1.01 (*2)	V	①
		V _{OUT(T)} <2.0V, V _{CE} =V _{IN} , I _{OUT} =10mA (*3)	V _{OUT(T)} -20mV (*2)	V _{OUT(T)} (*2)	V _{OUT(T)} +20mV (*2)	V	
Maximum Output Current	I _{OUT} MAX	V _{CE} =V _{IN}	300	-	-	mA	①
Load Regulation	ΔV _{OUT}	V _{CE} =V _{IN} , 0.1mA≤I _{OUT} ≤300mA	-	25	45	mV	①
Dropout Voltage	V _{dif} (*4)	V _{CE} =V _{IN} , I _{OUT} =300mA		E-1		mV	①
Supply Current	I _{SS}	V _{CE} =V _{IN}	-	100	220	μA	②
Stand-by Current	I _{STBY}	V _{CE} =V _{SS}	-	0.01	0.4	μA	②
Line Regulation	ΔV _{OUT} / (ΔV _{IN} ·V _{OUT})	V _{OUT(T)} +0.5V≤V _{IN} ≤5.5V V _{CE} =V _{IN} , I _{OUT} =50mA	-	0.01	0.1	%/V	①
Input Voltage	V _{IN}	-	1.6	-	5.5	V	①
Output Voltage Temperature Characteristics	ΔV _{OUT} / (ΔT _a ·V _{OUT})	V _{CE} =V _{IN} , I _{OUT} =10mA -40°C≤T _a ≤85°C	-	±100	-	ppm / °C	①
Ripple Rejection Rate	PSRR	V _{OUT(T)} <2.5V V _{IN} =3.0V _{DC} +0.5V _{p-pAC} V _{CE} =V _{OUT(T)} +1.0V I _{OUT} =30mA, f=1kHz	-	80	-	dB	③
		V _{OUT(T)} ≥2.5V V _{IN} ={V _{OUT(T)} +1.0} V _{DC} +0.5V _{p-pAC} V _{CE} =V _{OUT(T)} +1.0V I _{OUT} =30mA, f=1kHz					
Current Limit	I _{LIM}	V _{CE} =V _{IN}	310	400	-	mA	①
Short Current	I _{SHORT}	V _{CE} =V _{IN} , V _{OUT} =V _{SS}	-	50	-	mA	①
CE High Level Voltage	V _{CEH}	-	1.0	-	5.5	V	④
CE Low Level Voltage	V _{CEL}	-	-	-	0.3	V	④
CE High Level Current (A/B/E/F Type)	I _{CEH}	V _{CE} =V _{IN} =5.5V	-0.1	-	0.1	μA	④
CE High Level Current (C/D/G/H Type)	I _{CEH}	V _{CE} =V _{IN} =5.5V	3.0	5.5	9.0	μA	④
CE Low Level Current	I _{CEL}	V _{CE} =V _{SS}	-0.1	-	0.1	μA	④
CL Discharge Resistance (Only B/D/F/H Type)	R _{DCHG}	V _{IN} =5.5V, V _{OUT} =2.0V, V _{CE} =V _{SS}	-	300	-	Ω	①
Inrush Current (Only E/F/G/H Type)	I _{rush}	V _{IN} =V _{CE} =5.5V	-	150	-	mA	⑤
Thermal Shutdown Detect Temperature	T _{TSD}	Junction Temperature	-	150	-	°C	①
Thermal Shutdown Release Temperature	T _{TSR}	Junction Temperature	-	120	-	°C	
Thermal Shutdown Hysteresis Width	T _{TSD} - T _{TSR}	Junction Temperature	-	30	-	°C	

NOTE:

*1: V_{OUT(E)}: Effective output voltage

(i.e. the output voltage when "V_{OUT(T)}+1.0V" is provided at the V_{IN} pin while maintaining a certain I_{OUT} value.)

*2: V_{OUT(T)}: Nominal output voltage

*3: The standard output voltage is specified in V_{OUT(T)}±20mV where V_{OUT(T)}<2.0V.

*4: V_{dif}={V_{IN1}{*5}-V_{OUT1}{*6}} (V_{IN1}≥1.6V)

*5: V_{IN1}=The input voltage when V_{OUT1} appears as input voltage is gradually decreased.

*6: V_{OUT1}=A voltage equal to 98% of the output voltage whenever an amply stabilized I_{OUT} {V_{OUT(T)}+1.0V} is input

*7: Unless otherwise stated regarding input voltage conditions, V_{IN}=V_{OUT(T)}+1.0V.



[查询XC6223供应商](#)**ELECTRICAL CHARACTERISTICS (Continued)****● Voltage Chart 1**

SYMBOL PARAMETER NOMINAL OUTPUT VOLTAGE (V)	E-0		E-1	
	OUTPUT VOLTAGE (V)		DROPOUT VOLTAGE (mV)	
V _{OUT(T)}	V _{OUT(E)}		V _{dif}	
	MIN	MAX	TYP	MAX
1.20	1.1800	1.2200	480	630
1.25	1.2300	1.2700		
1.30	1.2800	1.3200	440	480
1.35	1.3300	1.3700		
1.40	1.3800	1.4200		
1.45	1.4300	1.4700	420	460
1.50	1.4800	1.5200		
1.55	1.5300	1.5700		
1.60	1.5800	1.6200		
1.65	1.6300	1.6700		
1.70	1.6800	1.7200	400	440
1.75	1.7300	1.7700		
1.80	1.7800	1.8200		
1.85	1.8300	1.8700	300	410
1.90	1.8800	1.9200		
1.95	1.9300	1.9700		
2.00	1.9800	2.0200		
2.05	2.0295	2.0705		
2.10	2.0790	2.1210		
2.15	2.1285	2.1715		
2.20	2.1780	2.2220		
2.25	2.2275	2.2725		
2.30	2.2770	2.3230		
2.35	2.3265	2.3735		
2.40	2.3760	2.4240		
2.45	2.4255	2.4745		
2.50	2.4750	2.5250		
2.55	2.5245	2.5755		
2.60	2.5740	2.6260		
2.65	2.6235	2.6765		
2.70	2.6730	2.7270		
2.75	2.7225	2.7775		

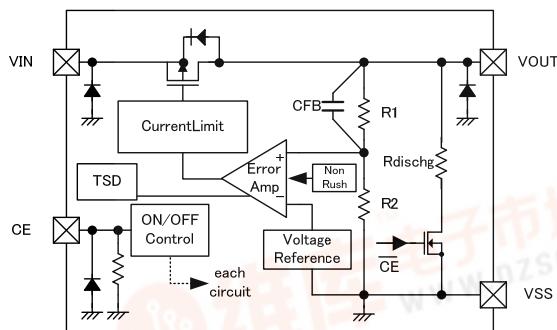
■ ELECTRICAL CHARACTERISTICS (Continued)

● Voltage Chart2

SYMBOL PARAMETER NOMINAL OUTPUT VOLTAGE (V)	E-0		E-1	
	OUTPUT VOLTAGE (V)		DROPOUT VOLTAGE (mV)	
V _{OUT(T)}	V _{OUT(E)}		V _{dif}	
	MIN.	MAX.	TYP.	MAX.
2.80	2.7720	2.8280	240	350
2.85	2.8215	2.8785		
2.90	2.8710	2.9290	200	305
2.95	2.9205	2.9795		
3.00	2.9700	3.0300	200	305
3.05	3.0195	3.0805		
3.10	3.0690	3.1310	200	305
3.15	3.1185	3.1815		
3.20	3.1680	3.2320	200	305
3.25	3.2175	3.2825		
3.30	3.2670	3.3330	200	305
3.35	3.3165	3.3835		
3.40	3.3660	3.4340	200	305
3.45	3.4155	3.4845		
3.50	3.4650	3.5350	200	305
3.55	3.5145	3.5855		
3.60	3.5640	3.6360	200	305
3.65	3.6135	3.6865		
3.70	3.6630	3.7370	200	305
3.75	3.7125	3.7875		
3.80	3.7620	3.8380	200	305
3.85	3.8115	3.8885		
3.90	3.8610	3.9390	200	305
3.95	3.9105	3.9895		
4.00	3.9600	4.0400	200	305

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■ OPERATIONAL EXPLANATION



The voltage divided by resistors R1 & R2 is compared with the internal reference voltage by the error amplifier. The P-channel MOSFET which is connected to the V_{OUT} pin is then driven by the subsequent output signal. The output voltage at the V_{OUT} pin is controlled and stabilized by a system of negative feedback. The current limit circuit and short circuit protection operate in relation to the level of output current and heat dissipation. Further, the IC's internal circuitry can be shutdown via the CE pin signal.

<Low ESR Capacitor>

The XC6223 series needs an output capacitor C_L for phase compensation. In order to ensure the stable phase compensation, please place an output capacitor of 1.0 μ F or bigger at the V_{OUT} pin and V_{SS} pin as close as possible. For a stable power input, please connect an input capacitor (C_{IN}) of 1.0 μ F between the V_{IN} pin and the V_{SS} pin.

<Current Limiter, Short-Circuit Protection>

The protection circuit operates as a combination of an output current limiter and fold-back short circuit protection. When load current reaches the current limit level, the output voltage drops. As a result, the load current starts to reduce with showing fold-back curve. The output current finally falls at the level of 50mA when the output pin is short-circuited.

<CE Pin>

The IC's internal circuitry can be shutdown via the signal from the CE pin. In shutdown mode, the XC6223B/D/F/H series enables the electric charge at the output capacitor (C_L) to be discharged via the internal auto-discharge switch, and as a result the V_{OUT} pin quickly returns to the V_{SS} level. When the CE pin is open, the output voltage becomes undefined state in the XC6223A/B/E/F series because of a high active and no pull-down. On the other hand, the XC6223C/D/G/H series has a pull-down resistor at the CE pin inside, so that the CE pin input current flows.

<Thermal Shutdown>

The over heat protection circuit is built-in with the XC6223 series. When the junction temperature of the IC reaches the temperature limit level (150°C TYP.), the thermal shutdown circuit operates and the driver transistor will be turned off. The IC resumes its operation when the thermal shutdown function is released as a result of the junction temperature drops to the release point.

<Inrush Current Protection>

The inrush current protection circuit is built in the XC6223 series.

When the IC starts to operate, the protection circuit limits the inrush current from V_{IN} to V_{OUT} to charge C_L capacitor. This function is built in the XC6223E/F/G/H series.

XC6223 Series

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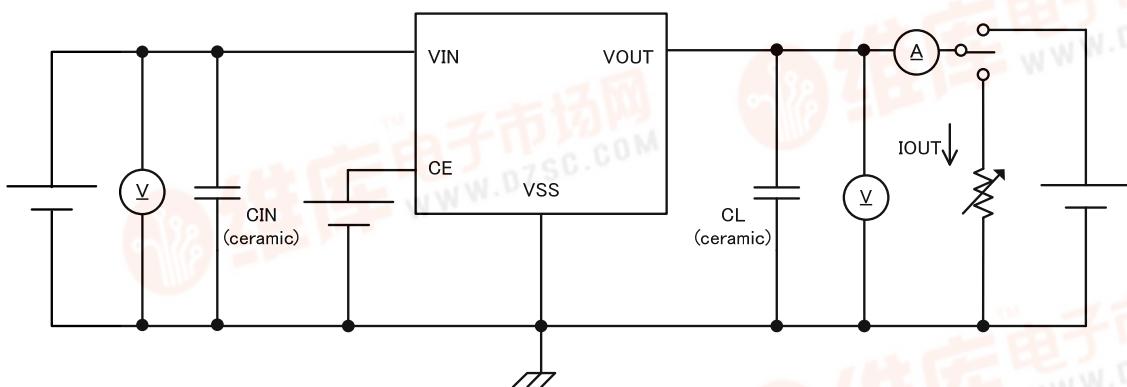
■ NOTES ON USE

1. Where wiring impedance is high, operations may become unstable due to the noise and/or phase lag depending on output current. Please strengthen V_{IN} and V_{SS} wiring in particular.
2. The input capacitor C_{IN} and the output capacitor C_L should be placed to the as close as possible with a shorter wiring.
3. The IC is controlled with constant current start-up. Start-up sequence control is requested to draw a load current after rising up the output voltage.
4. For temporary, transitional voltage drop or voltage rising phenomenon, the IC is liable to malfunction should the ratings be exceeded.
5. Torex places an importance on improving our products and its reliability.
However, by any possibility, we would request user fail-safe design and post-aging treatment on system or equipment.

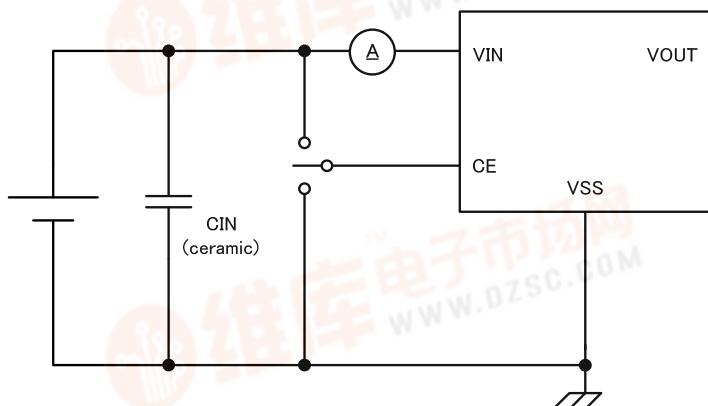
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■ TEST CIRCUITS

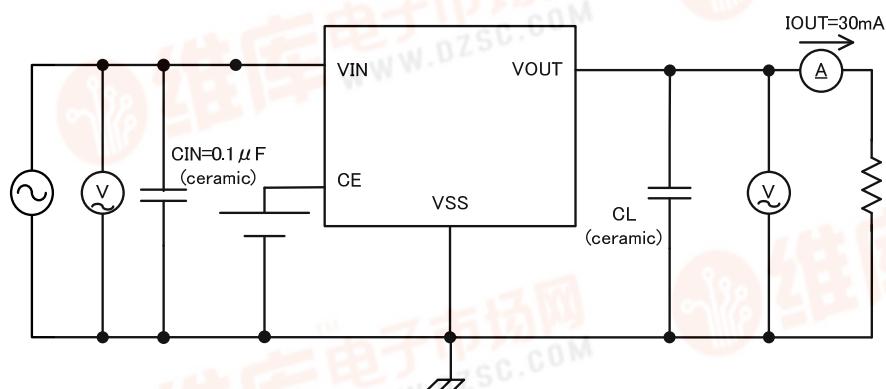
● Circuit ①



● Circuit ②

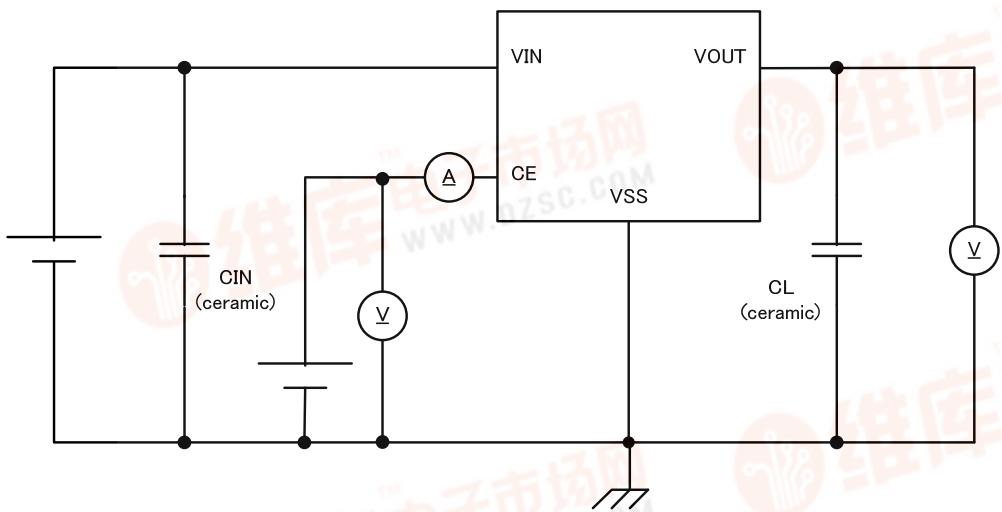


● Circuit ③

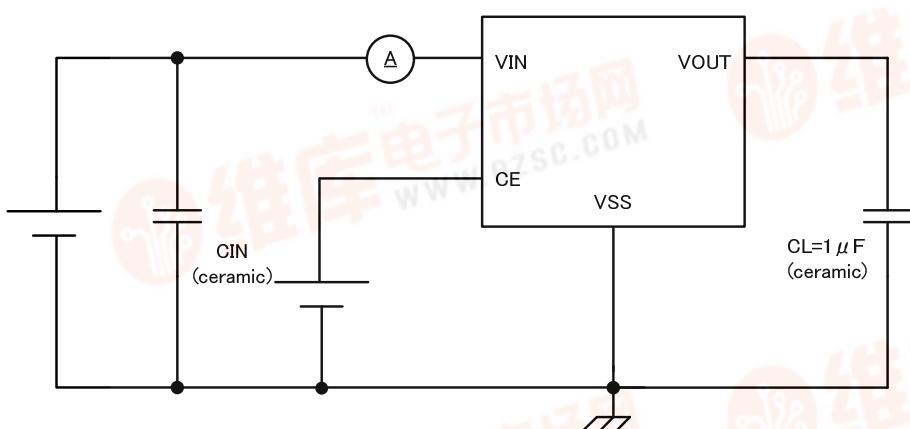


■ TEST CIRCUITS (Continued)

● Circuit ④



● Circuit ⑤

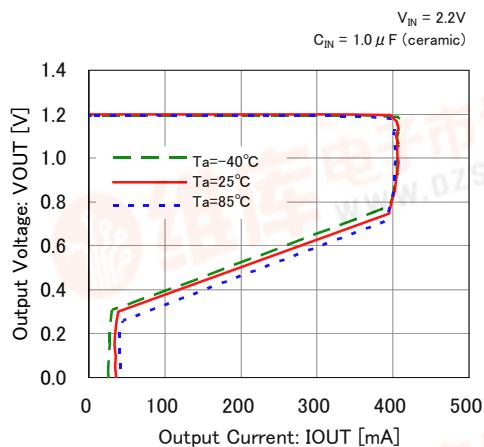


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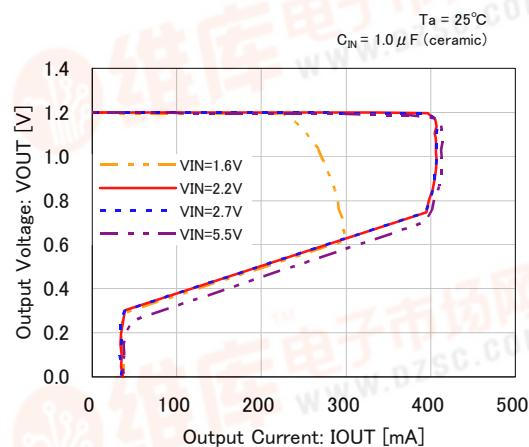
■ TYPICAL PERFORMANCE CHARACTERISTICS

(1) Output Voltage vs. Output Current

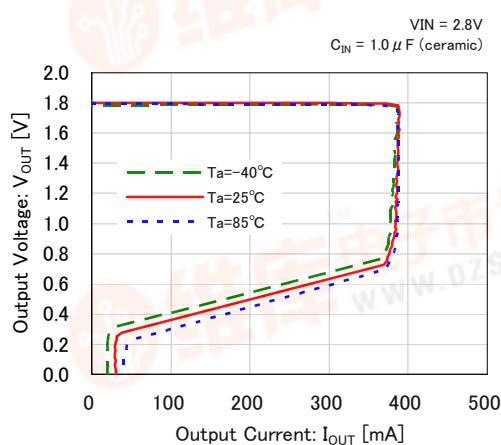
XC6223x121



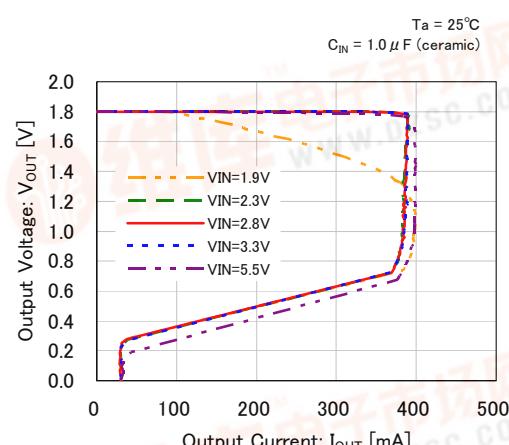
XC6223x121



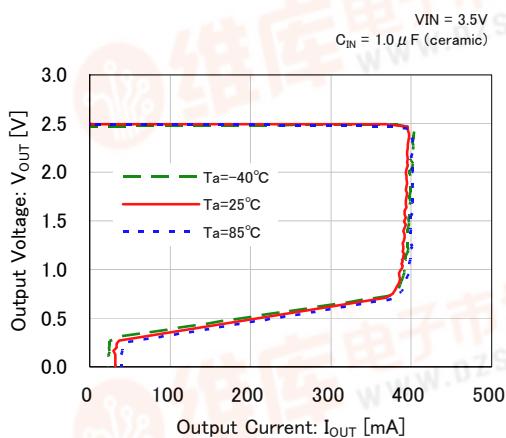
XC6223x181



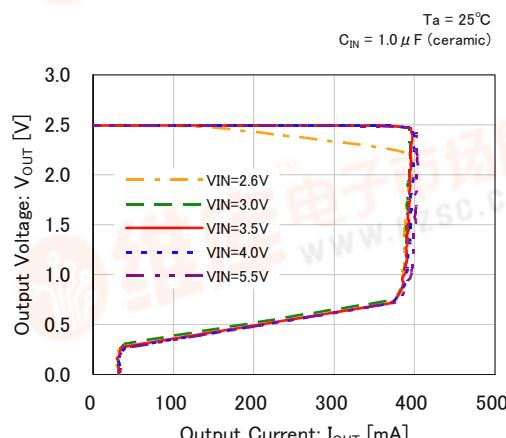
XC6223x181



XC6223x251

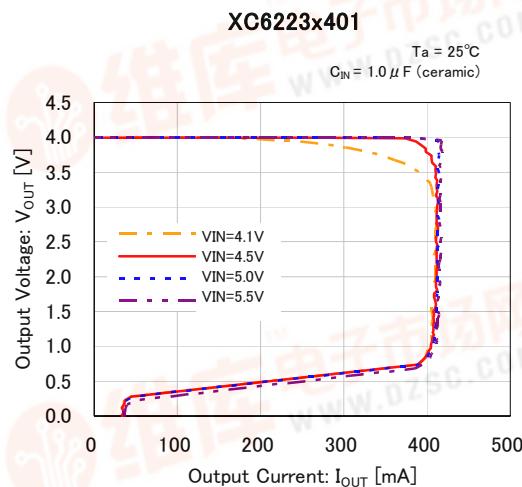
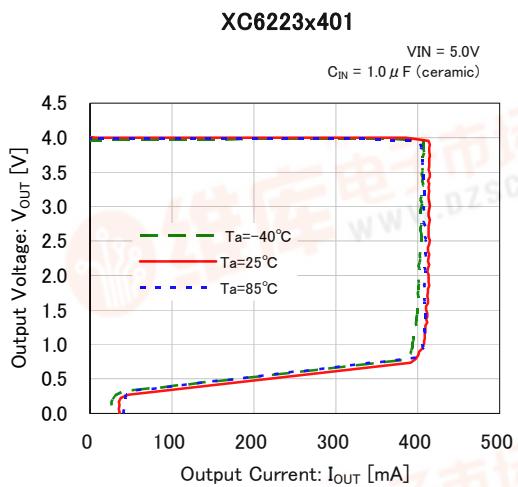


XC6223x251

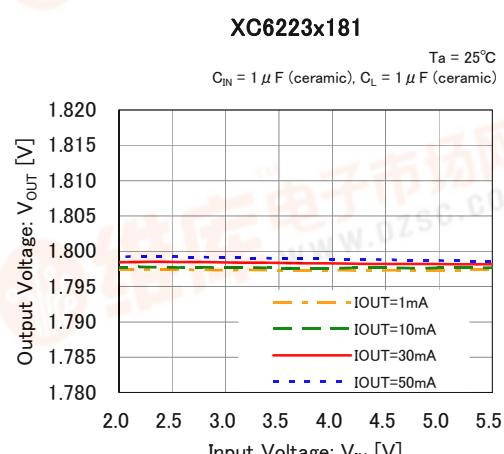
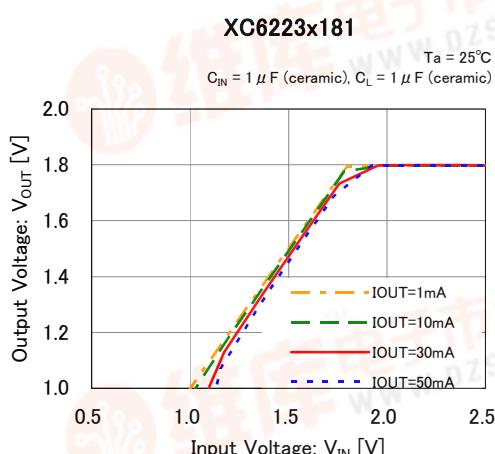
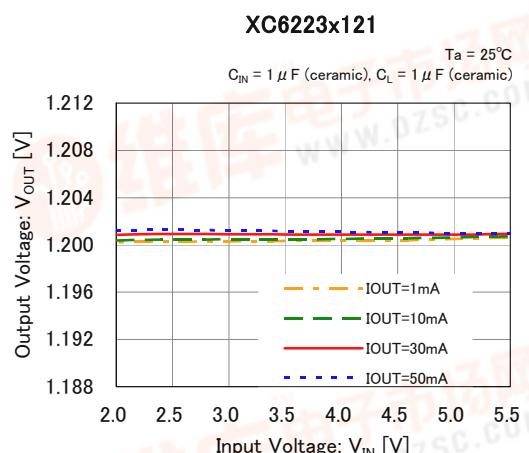
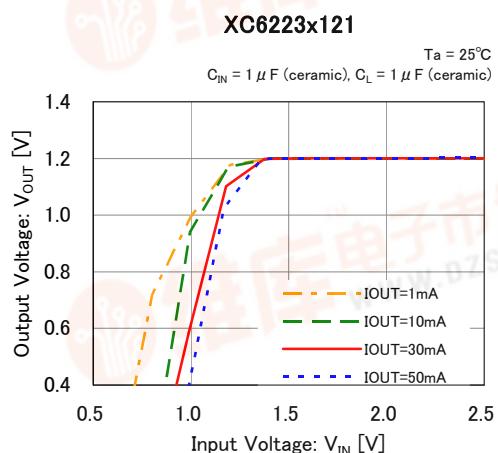


■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(1) Output Voltage vs. Output Current (Continued)



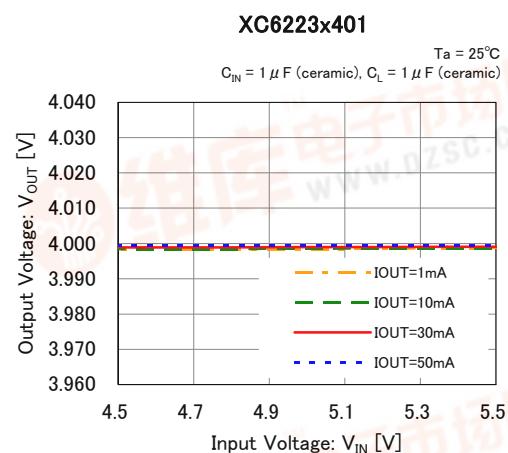
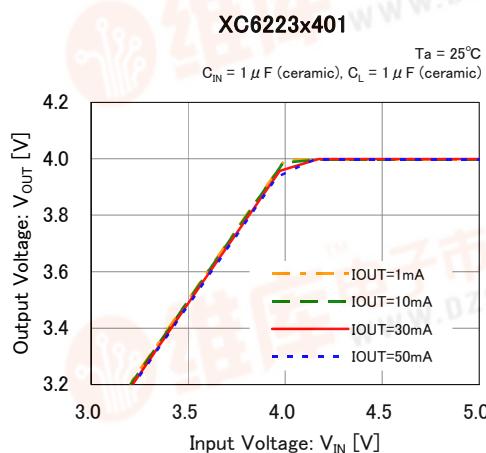
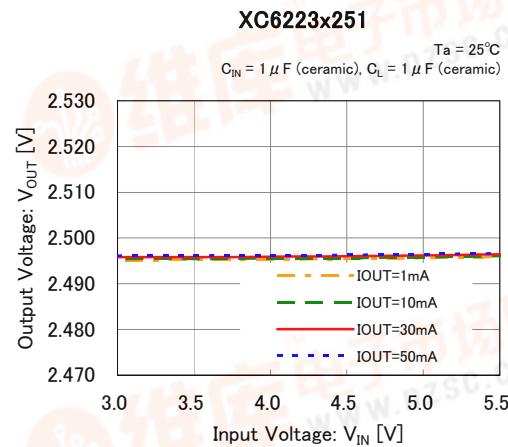
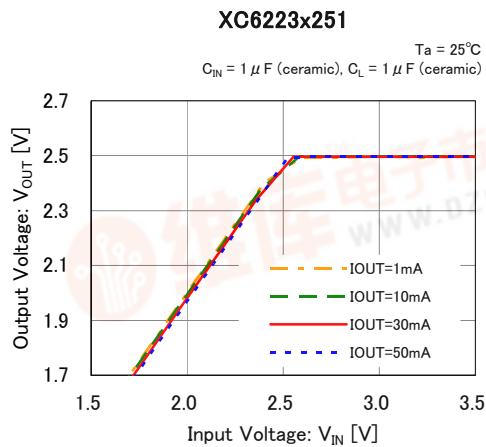
(2) Output Voltage vs. Input Voltage



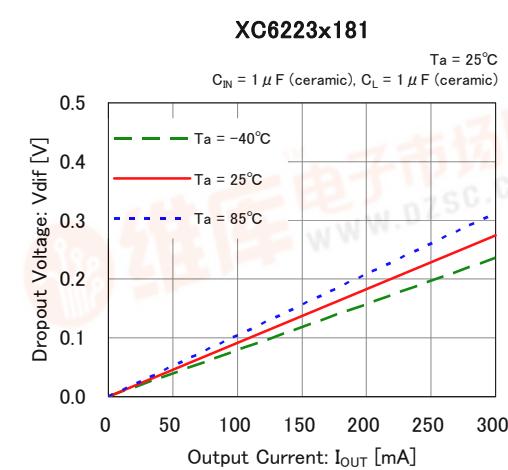
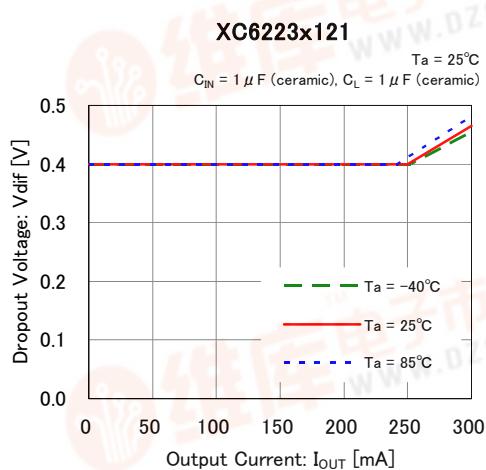
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■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(2) Output Voltage vs. Input Voltage (Continued)

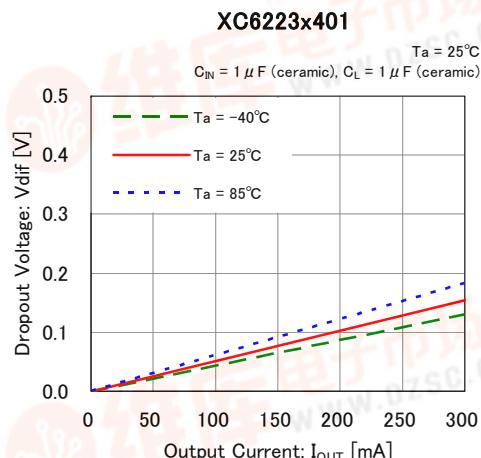
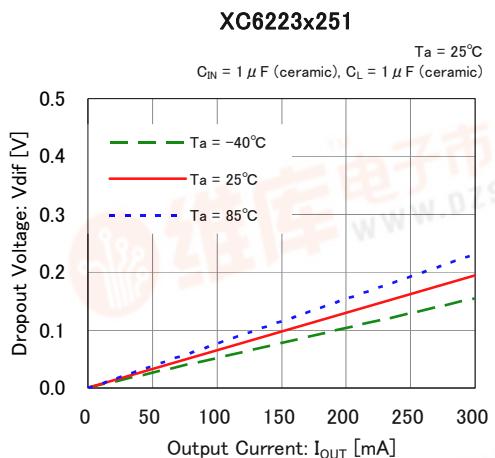


(3) Dropout Voltage vs. Output Current

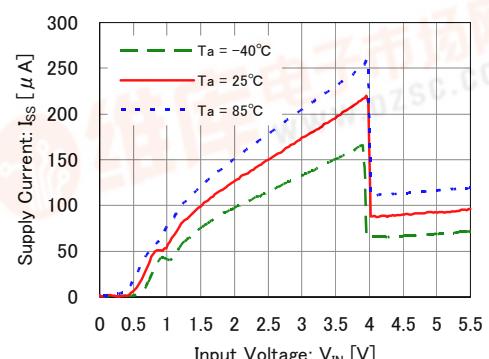
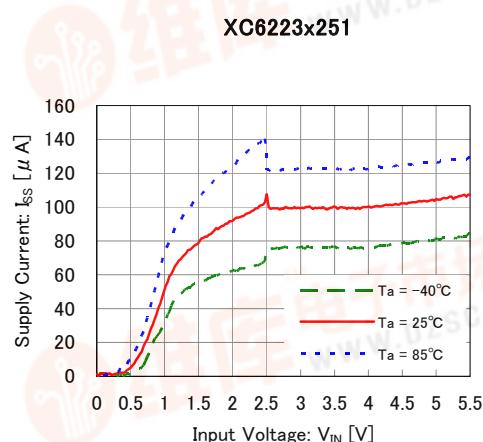
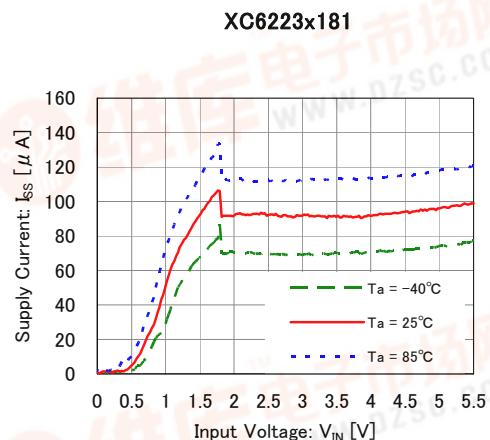
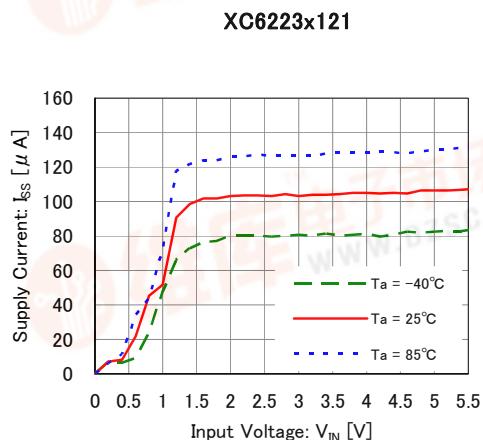


■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(3) Dropout Voltage vs. Output Current (Continued)



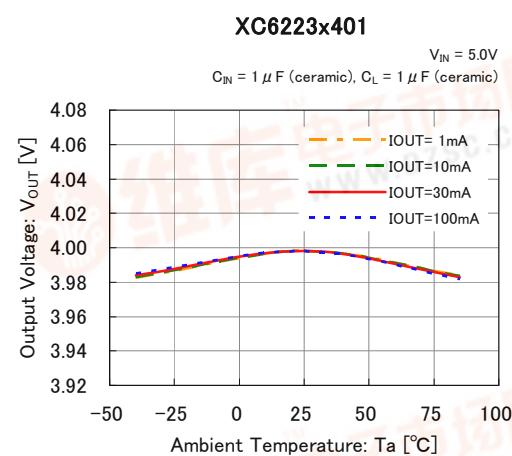
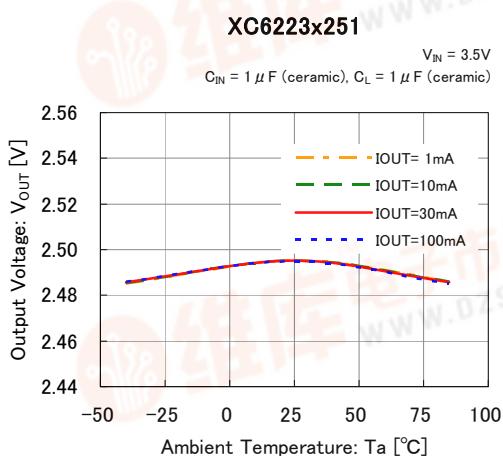
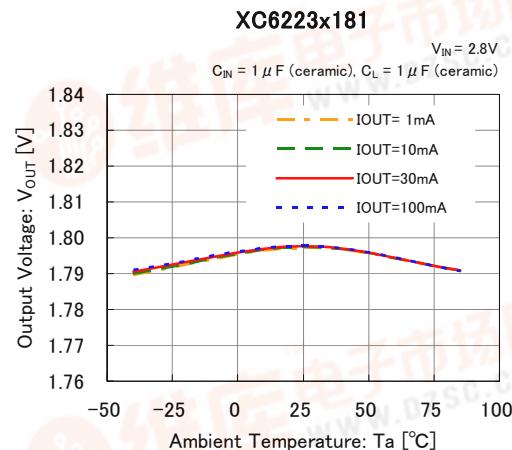
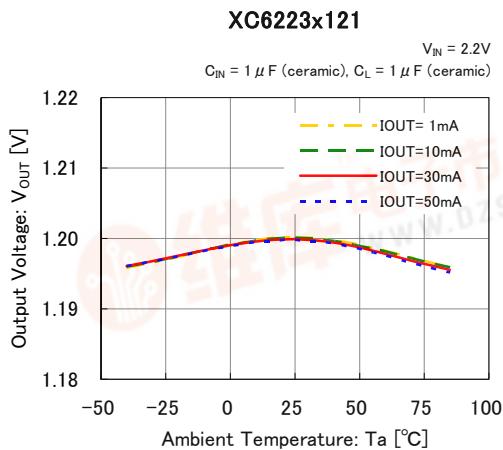
(4) Supply Current vs. Input Voltage



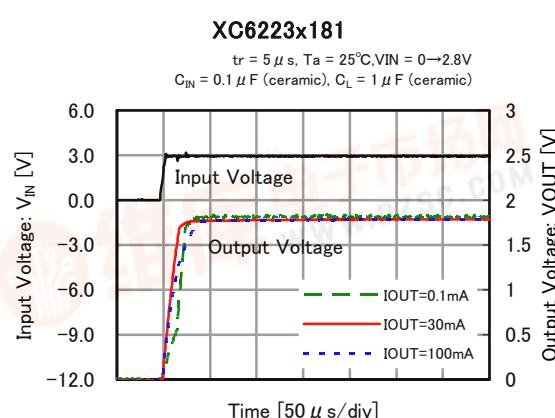
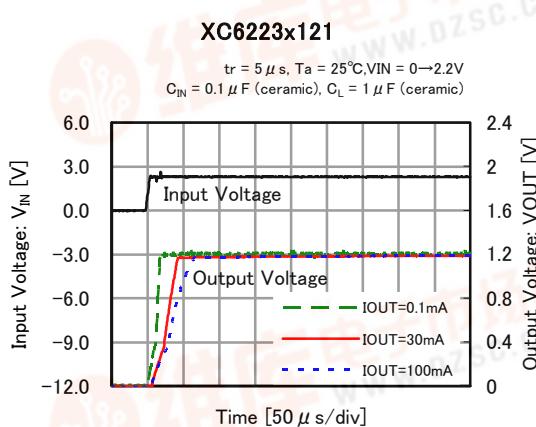
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■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(5) Output Voltage vs. Ambient Temperature



(6) Rising Response Time



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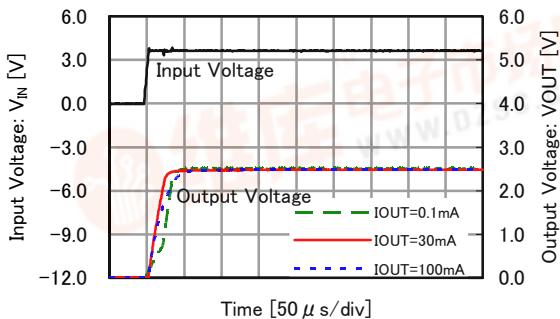
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■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(6) Rising Response Time (Continued)

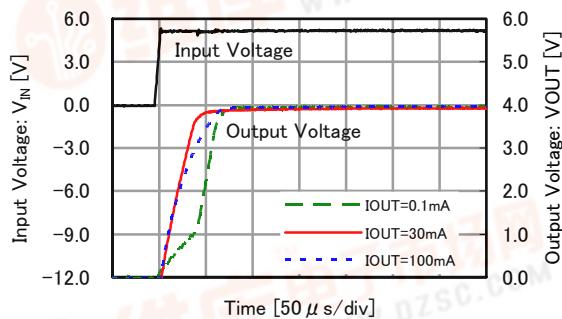
XC6223x251

$t_r = 5 \mu s$, $T_a = 25^\circ C$, $V_{IN} = 0 \rightarrow 3.5V$
 $C_{IN} = 0.1 \mu F$ (ceramic), $C_L = 1 \mu F$ (ceramic)



XC6223x401

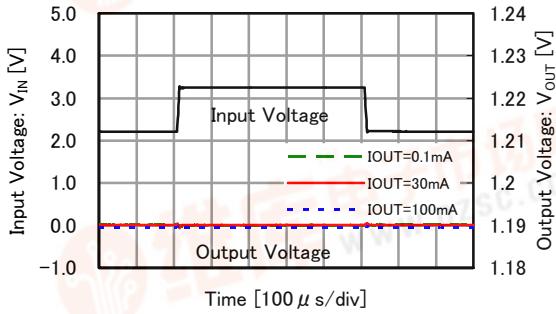
$t_r = 5 \mu s$, $T_a = 25^\circ C$, $V_{IN} = 0 \rightarrow 5.0V$
 $C_{IN} = 0.1 \mu F$ (ceramic), $C_L = 1 \mu F$ (ceramic)



(7) Input Transient Response

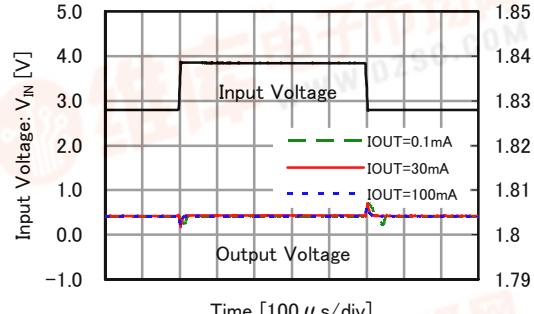
XC6223x121

$t_r = t_f = 5 \mu s$, $T_a = 25^\circ C$, $V_{IN} = 2.2V \leftrightarrow 3.2V$
 $C_{IN} = 0.1 \mu F$ (ceramic), $C_L = 1.0 \mu F$ (ceramic)



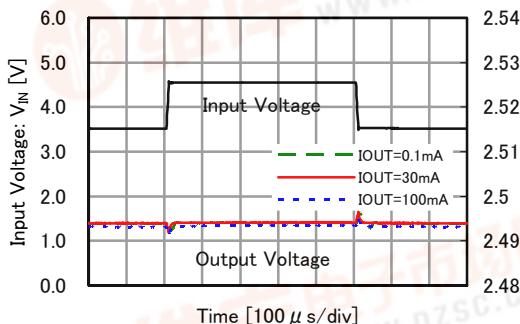
XC6223x181

$t_r = t_f = 5 \mu s$, $T_a = 25^\circ C$, $V_{IN} = 2.8V \leftrightarrow 3.8V$
 $C_{IN} = 0.1 \mu F$ (ceramic), $C_L = 1.0 \mu F$ (ceramic)



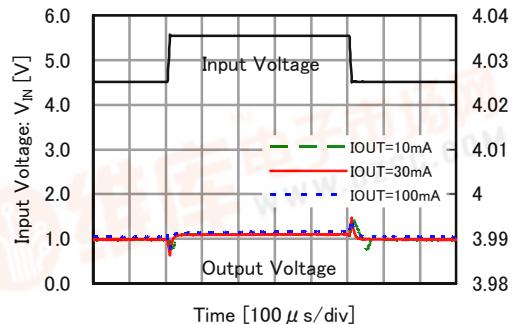
XC6223x251

$t_r = t_f = 5 \mu s$, $T_a = 25^\circ C$, $V_{IN} = 3.5V \leftrightarrow 4.5V$
 $C_{IN} = 0.1 \mu F$ (ceramic), $C_L = 1.0 \mu F$ (ceramic)



XC6223x401

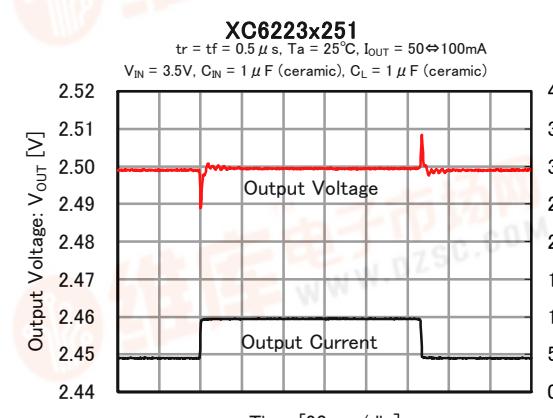
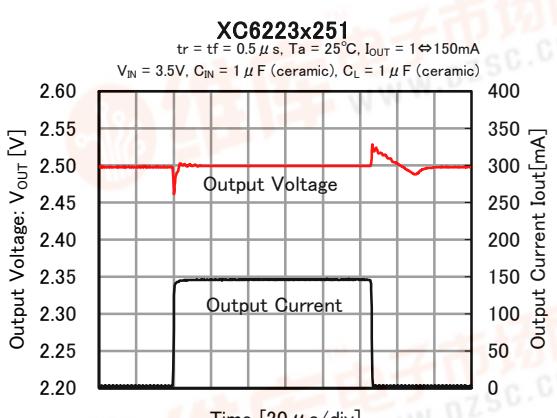
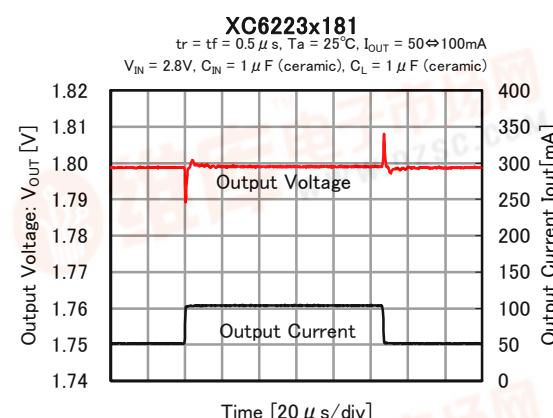
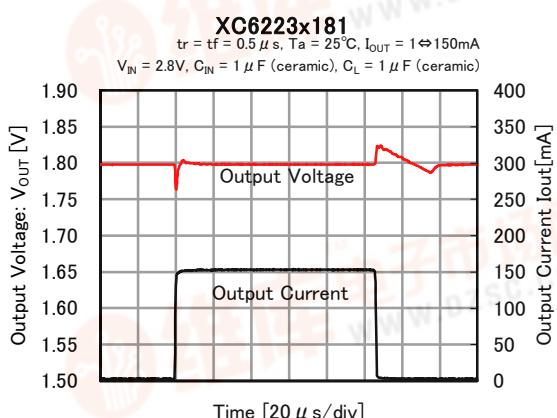
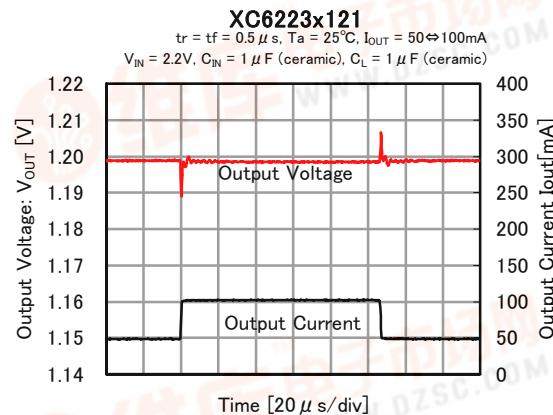
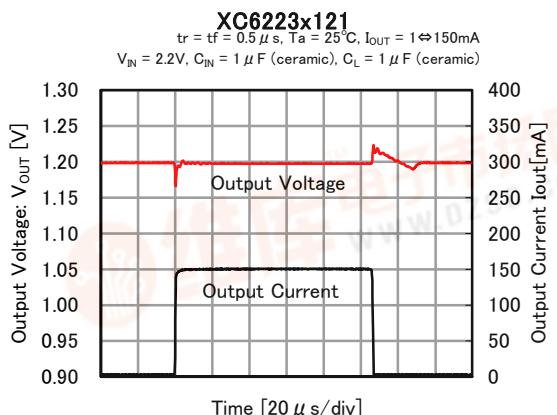
$t_r = t_f = 5 \mu s$, $T_a = 25^\circ C$, $V_{IN} = 4.5V \leftrightarrow 5.5V$
 $C_{IN} = 0.1 \mu F$ (ceramic), $C_L = 1.0 \mu F$ (ceramic)



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■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(8) Load Transient Response ($t_r=t_f=0.5 \mu s$)

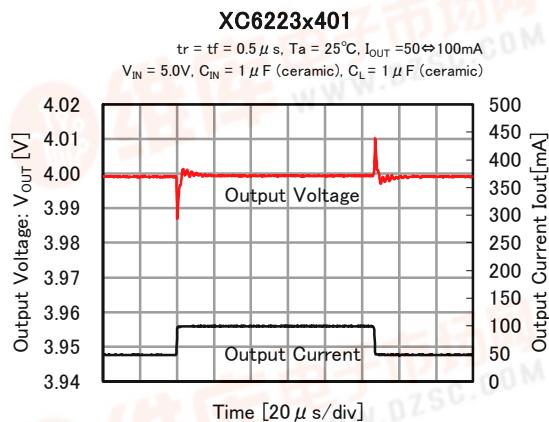
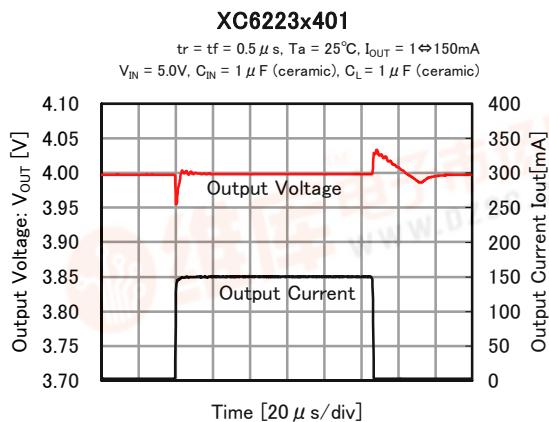


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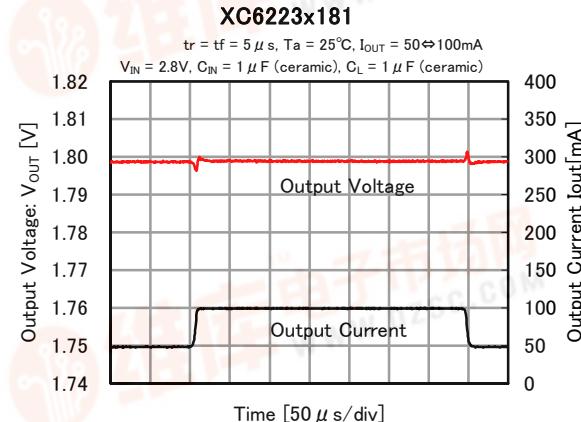
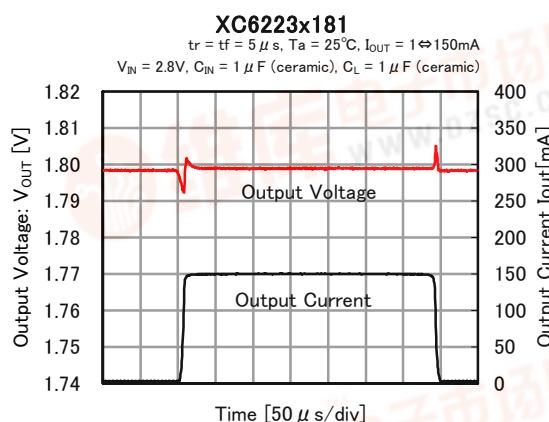
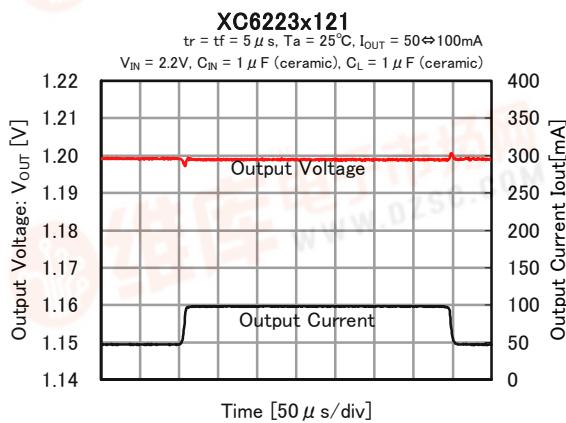
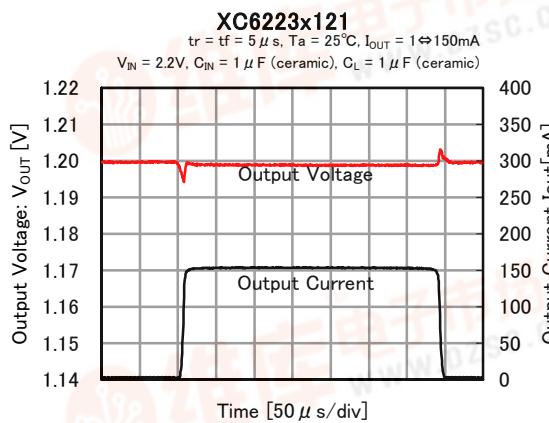
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■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(8) Load Transient Response ($t_r=t_f=0.5 \mu s$) (Continued)



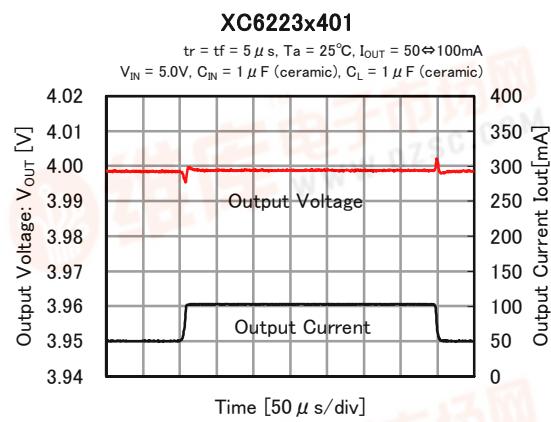
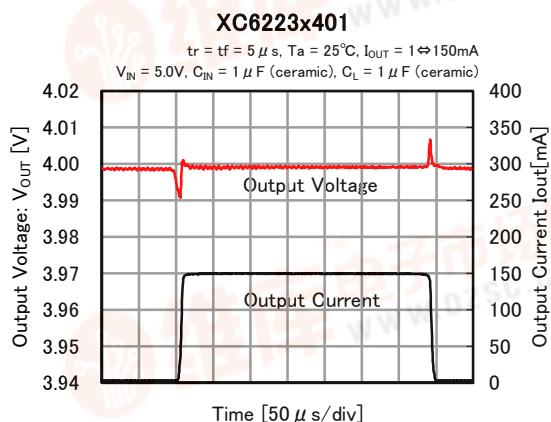
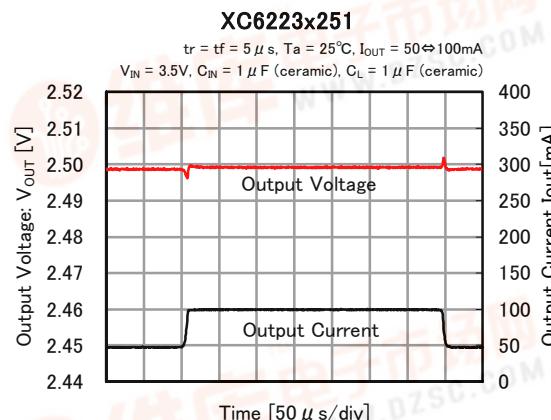
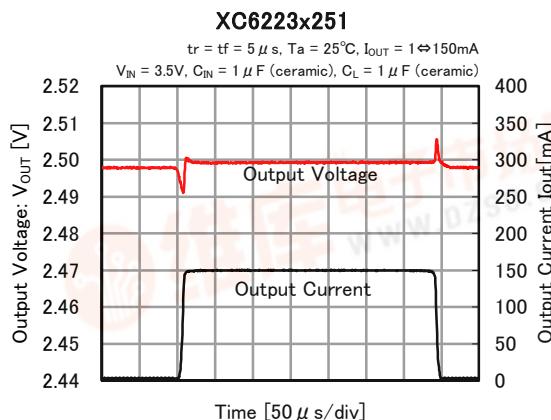
(8) Load Transient Response ($t_r=t_f=5 \mu s$) (Continued)



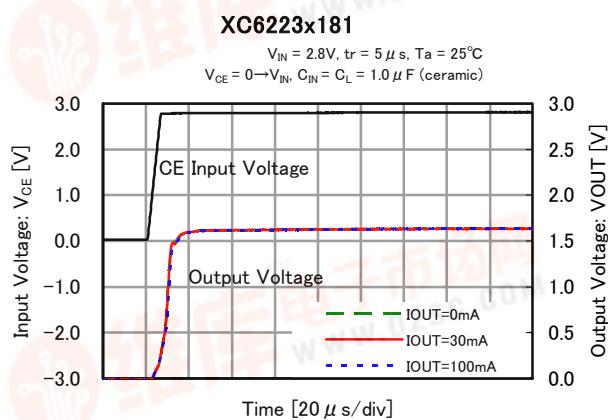
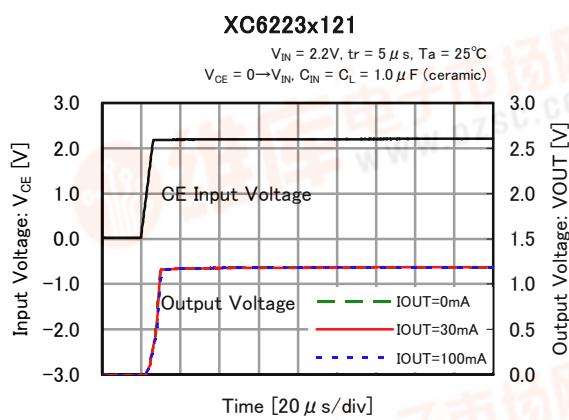
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■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(8) Load Transient Response ($t_r=t_f=5 \mu s$) (Continued)

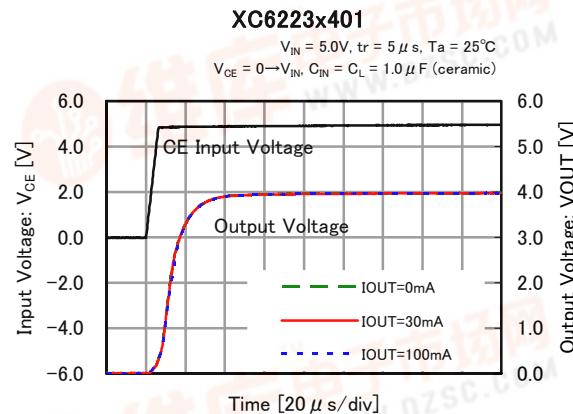
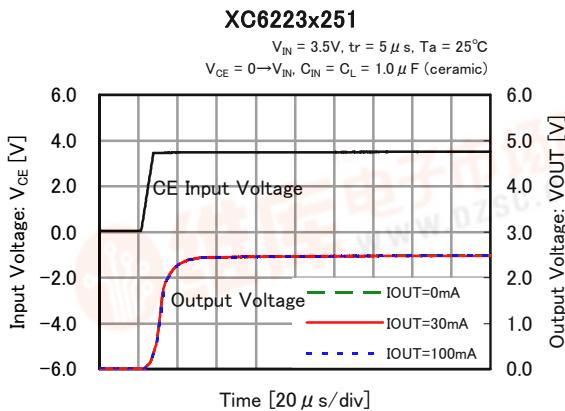


(9) CE Rising Response Time (A,B,C,D Type)

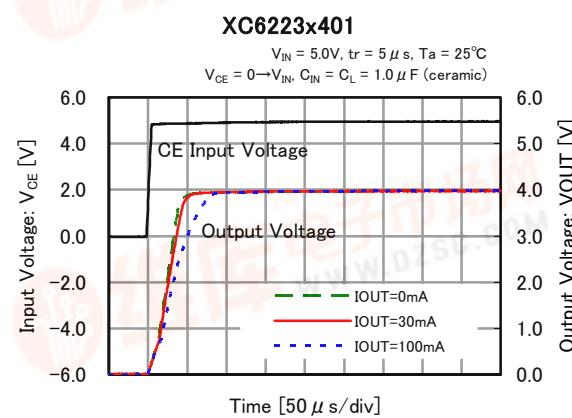
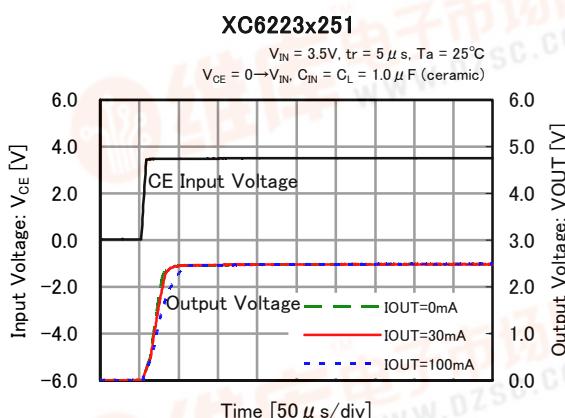
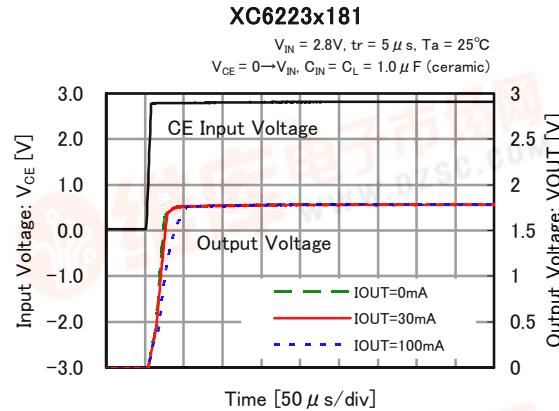
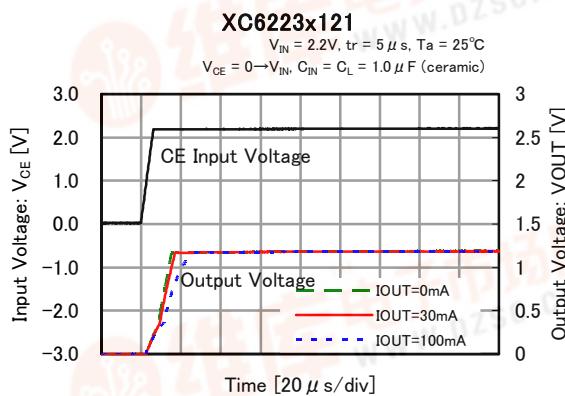


■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(9) CE Rising Response Time (A,B,C,D Type) (Continued)



(9) CE Rising Response Time (E,F,G,H Type) (Continued)



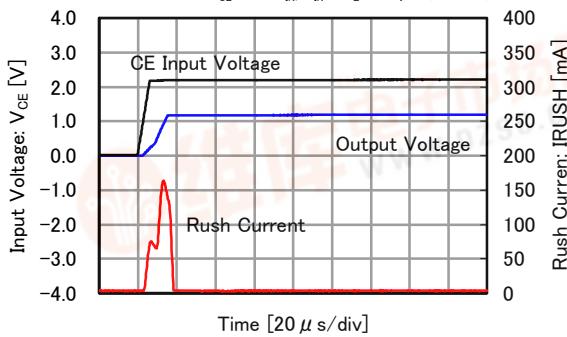
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■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(10) Inrush Current Response Time (E,F,G,H Type)

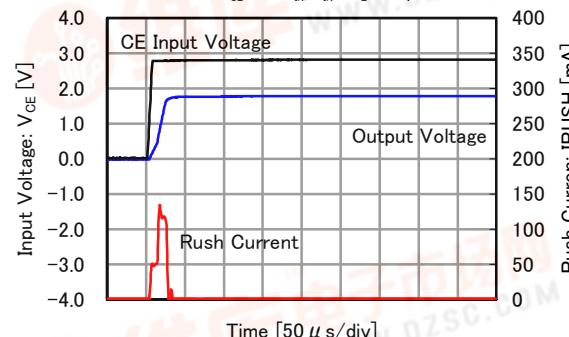
XC6223x121

$V_{IN} = 2.2V$, $tr = 5 \mu s$, $Ta = 25^\circ C$
 $V_{CE} = 0 \rightarrow V_{IN}$, $C_{IN} = C_L = 1.0 \mu F$ (ceramic)



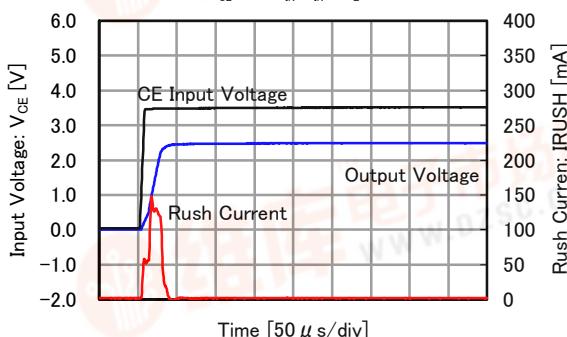
XC6223x181

$V_{IN} = 2.8V$, $tr = 5 \mu s$, $Ta = 25^\circ C$
 $V_{CE} = 0 \rightarrow V_{IN}$, $C_{IN} = C_L = 1.0 \mu F$ (ceramic)



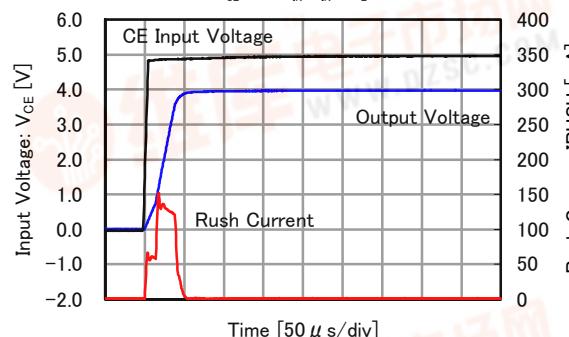
XC6223x251

$V_{IN} = 3.5V$, $tr = 5 \mu s$, $Ta = 25^\circ C$
 $V_{CE} = 0 \rightarrow V_{IN}$, $C_{IN} = C_L = 1.0 \mu F$ (ceramic)



XC6223x401

$V_{IN} = 5.0V$, $tr = 5 \mu s$, $Ta = 25^\circ C$
 $V_{CE} = 0 \rightarrow V_{IN}$, $C_{IN} = C_L = 1.0 \mu F$ (ceramic)

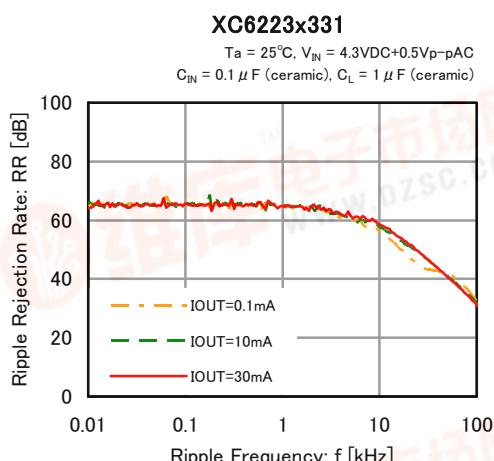
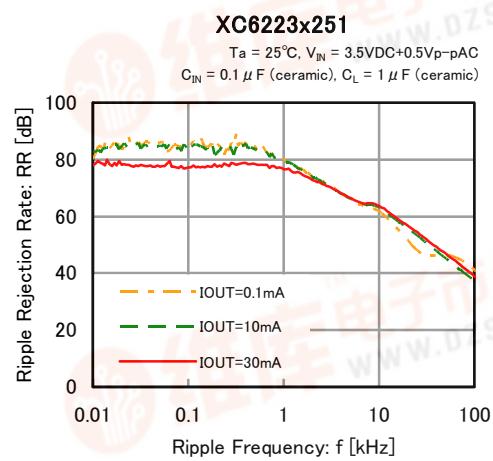
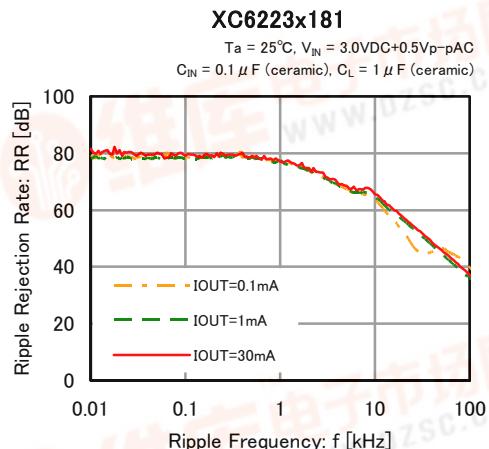
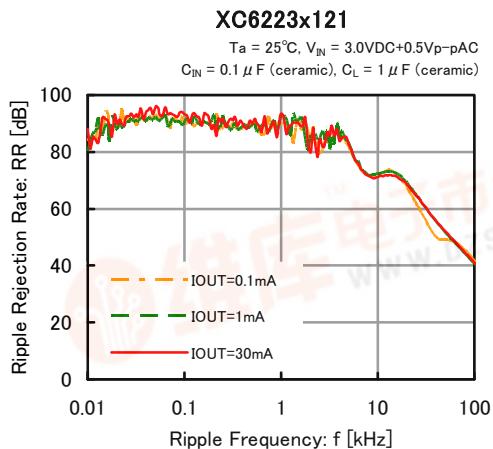


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■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

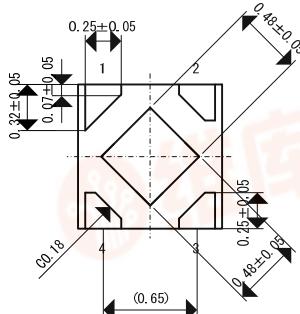
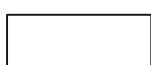
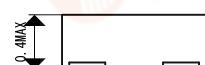
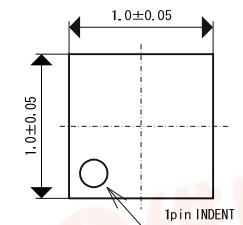
(11) Ripple Rejection Rate



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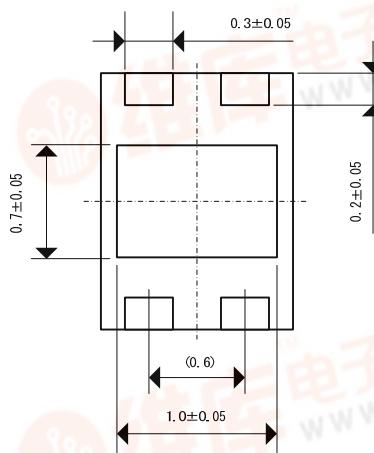
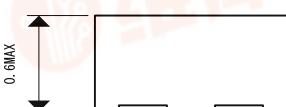
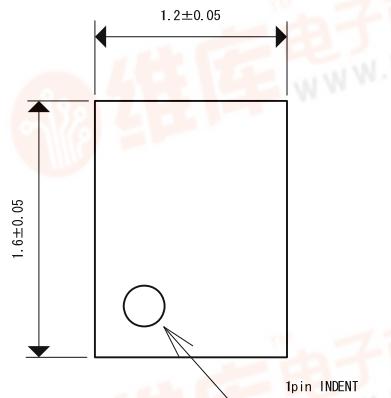
■PACKAGING INFORMATION

USPQ-4B03
(unit : mm)

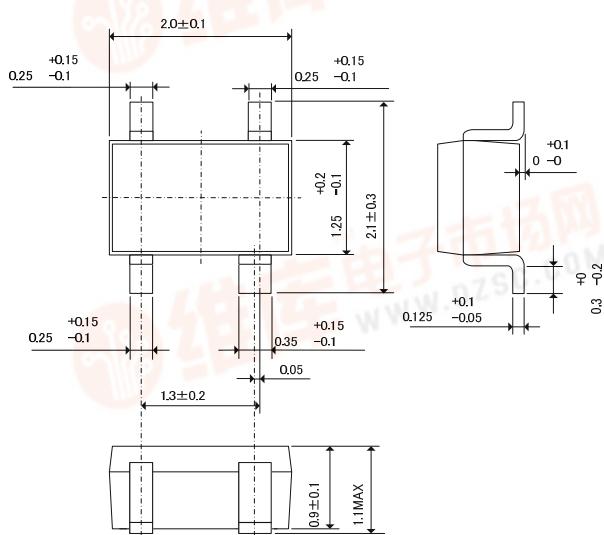


*The package don't have filet because side of lead is no plating.

USP-4
(unit : mm)

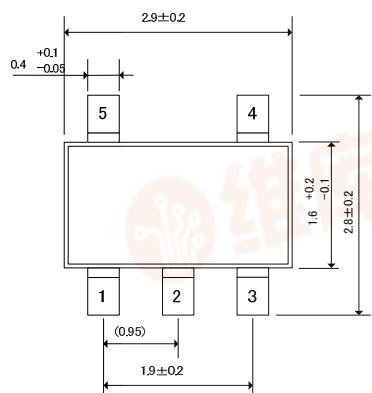


SSOT-24
(unit : mm)

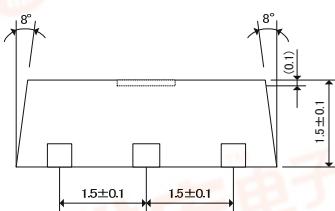
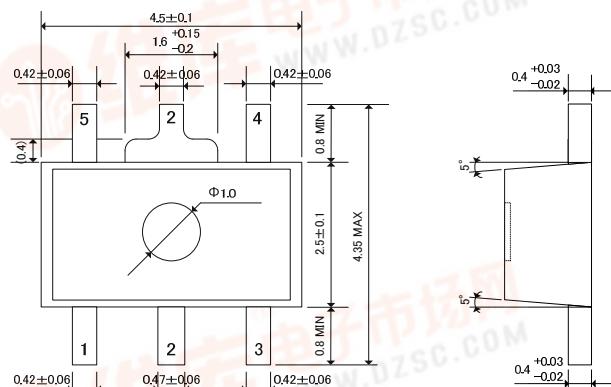


■PACKAGING INFORMATION (Continued)

SOT-25
(unit : mm)



SOT-89-5
(unit : mm)

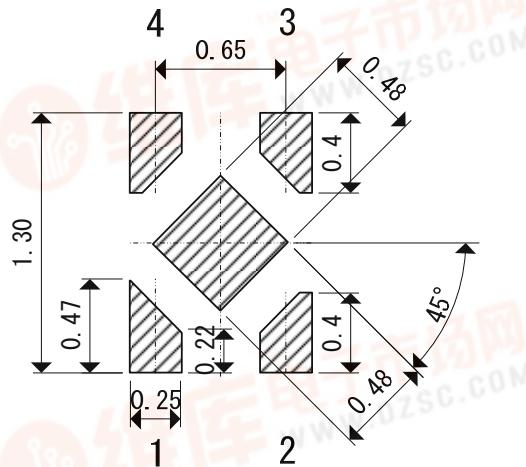


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■PACKAGING INFORMATION (Continued)

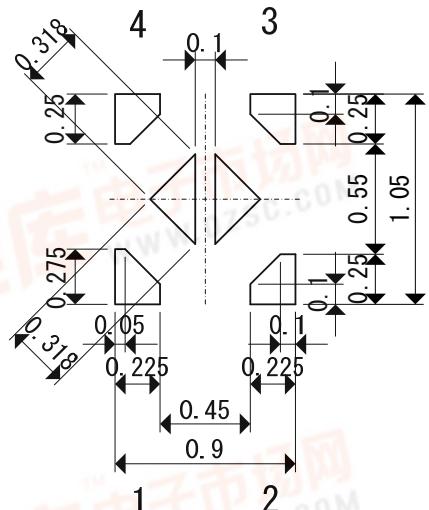
●USPQ-4B03 Reference Pattern Layout

(unit : mm)



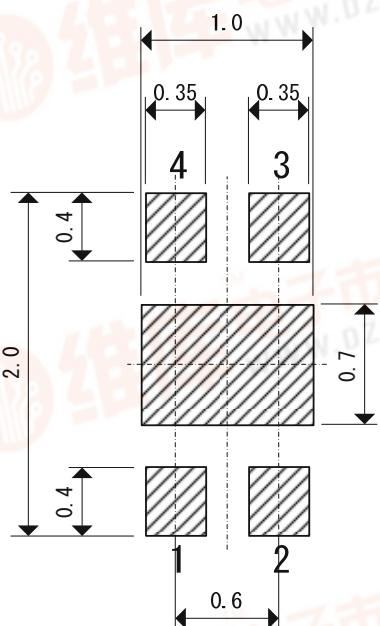
●USPQ-4B03 Reference Metal Mask Design

(unit : mm)



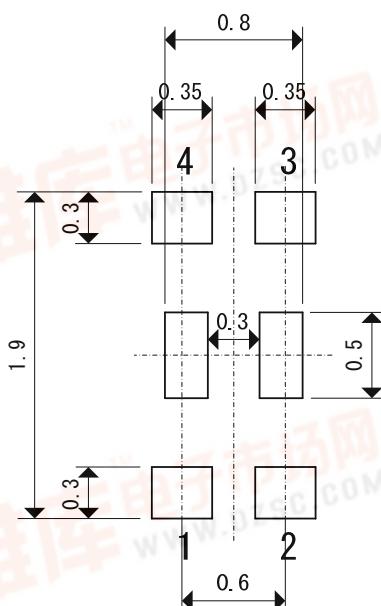
●USP-4 Reference Pattern Layout

(unit : mm)



●USP-4 Reference Metal Mask Design

(unit : mm)



■PACKAGING INFORMATION (Continued)

● USPQ-4B03 Power Dissipation

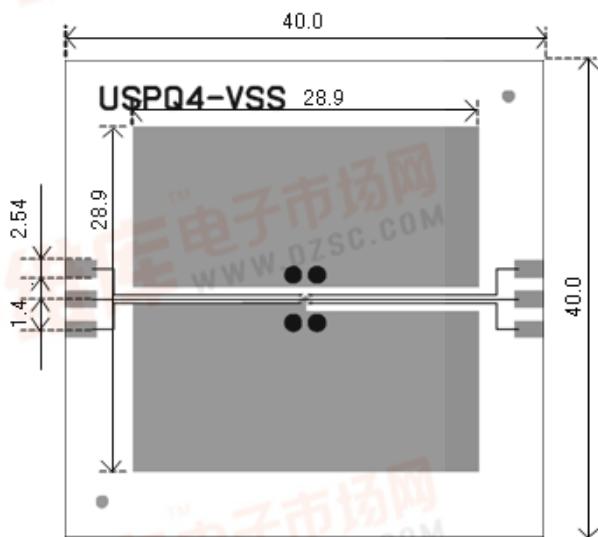
Power dissipation data for the USPQ-4B03 is shown in this page.

The value of power dissipation varies with the mount board conditions.

Please use this data as one of reference data taken in the described condition.

1. Measurement Condition (Reference data)

Condition	: Mount on a board
Ambient	: Natural convection
Soldering	: Lead (Pb) free
Board Dimensions	: 40 x 40 mm (1600mm ²)
Board Structure	: 4 Copper Layers Each layer is connected to the package heat-sink and terminal pin No.1. Each layer has approximately 800mm ² copper area.
Material	: Glass Epoxy (FR-4)
Thickness	: 1.6 mm
Through-hole	: 4 x 0.8 Diameter

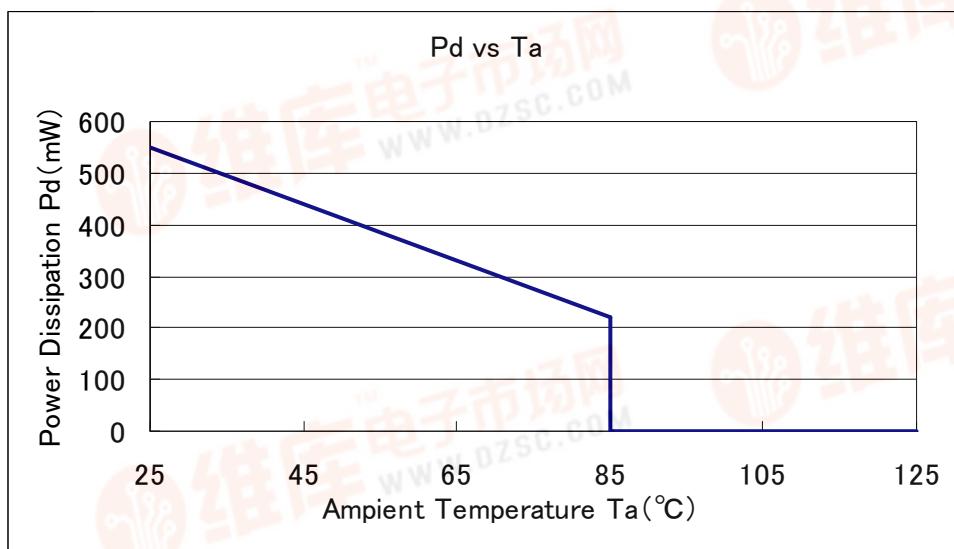


Evaluation Board (Unit: mm)

2. Power Dissipation vs. Ambient temperature

Board Mount (T_j max = 125°C)

Ambient Temperature (°C)	Power Dissipation Pd(mW)	Thermal Resistance (°C/W)
25	550	181.82
85	220	



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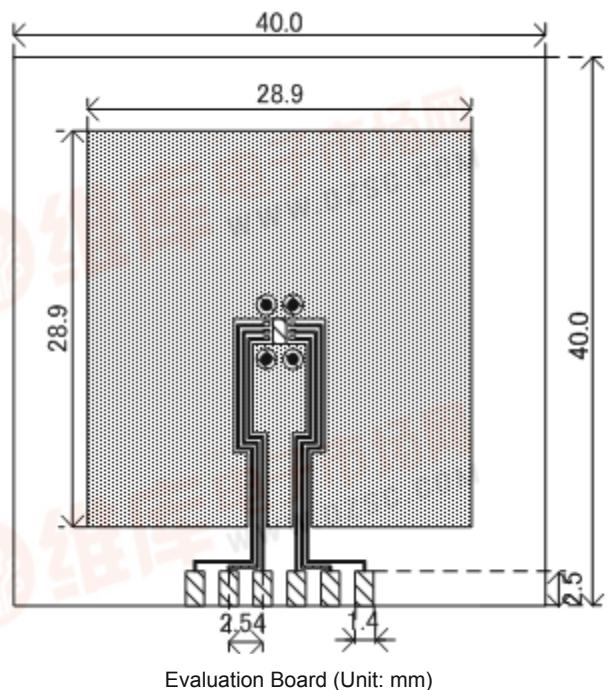
■PACKAGING INFORMATION (Continued)

● USP-4 Power Dissipation

Power dissipation data for the USP-4 is shown in this page.
 The value of power dissipation varies with the mount board conditions.
 Please use this data as one of reference data taken in the described condition.

1. Measurement Condition (Reference data)

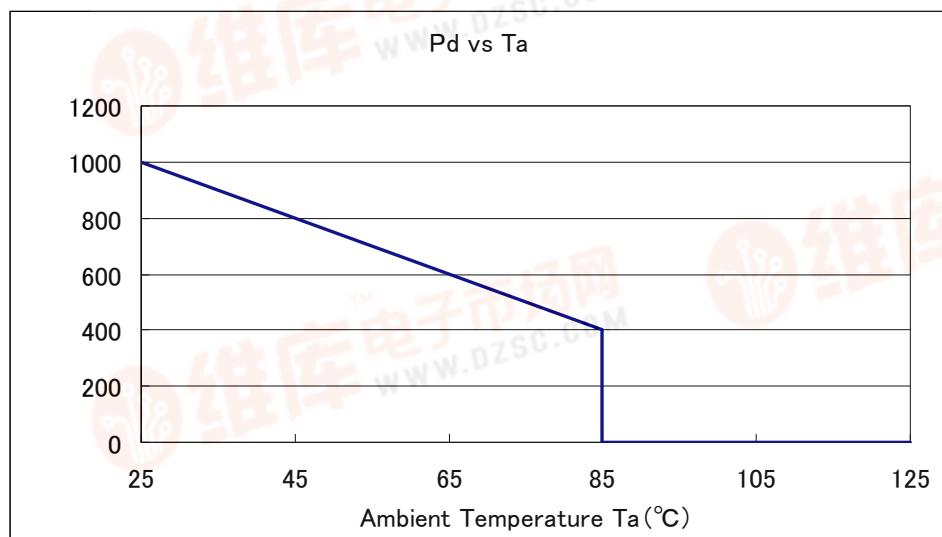
Condition: Mount on a board
 Ambient: Natural convection
 Soldering: Lead (Pb) free
 Board: Dimensions 40 x 40 mm (1600 mm² in one side)
 Copper (Cu) traces occupy 50% of the board area
 In top and back faces
 Package heat-sink is tied to the copper traces
 Material: Glass Epoxy (FR-4)
 Thickness: 1.6 mm
 Through-hole: 4 x 0.8 Diameter



2. Power Dissipation vs. Ambient temperature

Board Mount (T_j max = 125°C)

Ambient Temperature (°C)	Power Dissipation P_d (mW)	Thermal Resistance (°C/W)
25	1000	100.00
85	400	



■PACKAGING INFORMATION (Continued)

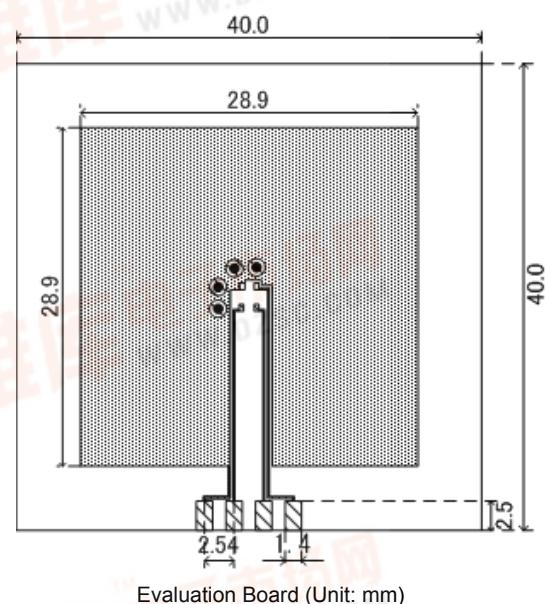
● SSOT-24 Power Dissipation

Power dissipation data for the SSOT-24 is shown in this page.

The value of power dissipation varies with the mount board conditions.
Please use this data as one of reference data taken in the described condition.

2. Measurement Condition (Reference data)

Condition: Mount on a board
Ambient: Natural convection
Soldering: Lead (Pb) free
Board: Dimensions 40 x 40 mm (1600 mm² in one side)
Copper (Cu) traces occupy 50% of the board area
In top and back faces
Package heat-sink is tied to the copper traces
Material: Glass Epoxy (FR-4)
Thickness: 1.6 mm
Through-hole: 4 x 0.8 Diameter

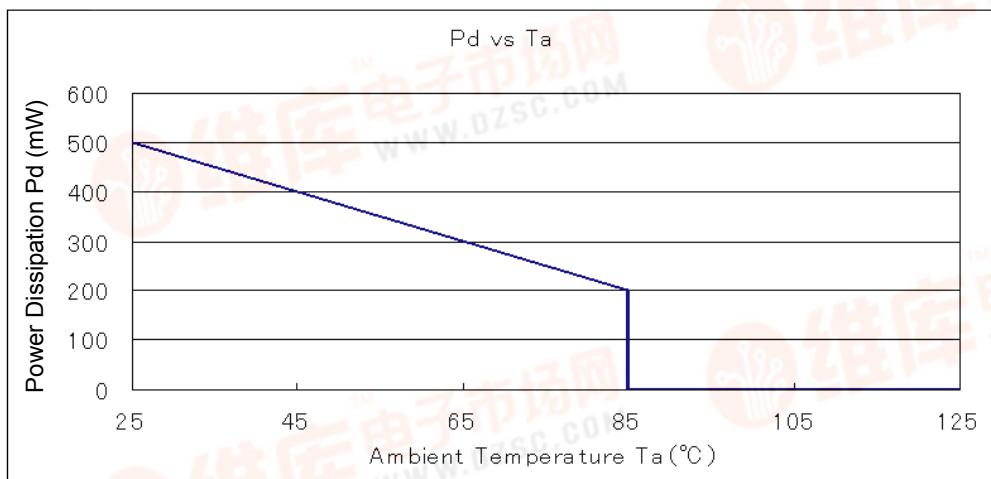


Evaluation Board (Unit: mm)

2. Power Dissipation vs. Ambient temperature

Board Mount (T_j max = 125°C)

Ambient Temperature (°C)	Power Dissipation P_d (mW)	Thermal Resistance (°C/W)
25	500	200.00
85	200	



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■PACKAGING INFORMATION (Continued)

● SOT-25 Power Dissipation

Power dissipation data for the SOT-25 is shown in this page.

The value of power dissipation varies with the mount board conditions.

Please use this data as one of reference data taken in the described condition.

1. Measurement Condition (Reference data)

Condition: Mount on a board

Ambient: Natural convection

Soldering: Lead (Pb) free

Board: Dimensions 40 x 40 mm (1600 mm² in one side)

Copper (Cu) traces occupy 50% of the board area

In top and back faces

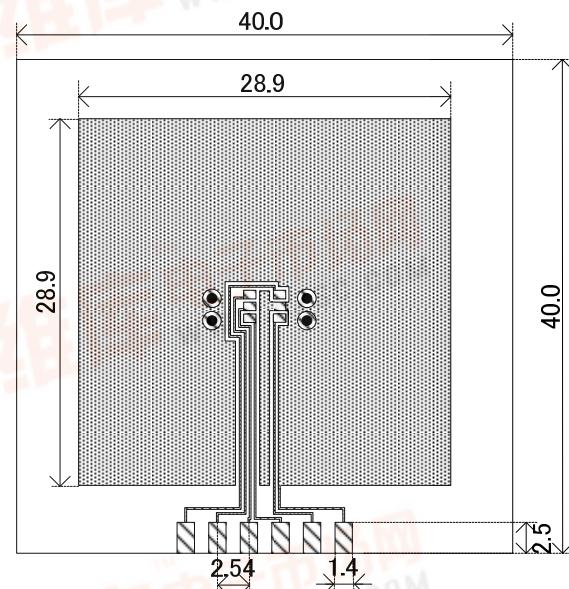
Package heat-sink is tied to the copper traces

(Board of SOT-26 is used.)

Material: Glass Epoxy (FR-4)

Thickness: 1.6 mm

Through-hole: 4 x 0.8 Diameter

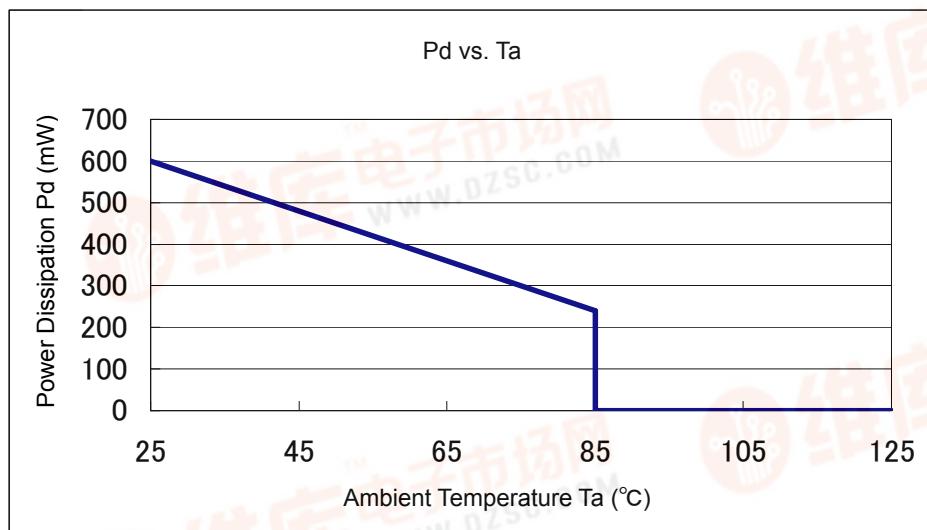


Evaluation Board (Unit: mm)

2. Power Dissipation vs. Ambient temperature

Board Mount (T_j max = 125°C)

Ambient Temperature(°C)	Power Dissipation Pd(mW)	Thermal Resistance (°C/W)
25	600	166.67
85	240	



■PACKAGING INFORMATION (Continued)

● SOT-89-5 Power Dissipation

Power dissipation data for the SOT-89-5 is shown in this page.

The value of power dissipation varies with the mount board conditions.

Please use this data as one of reference data taken in the described condition.

1. Measurement Condition (Reference data)

Condition: Mount on a board

Ambient: Natural convection

Soldering: Lead (Pb) free

Board: Dimensions 40 x 40 mm (1600 mm² in one side)

Copper (Cu) traces occupy 50% of the board area

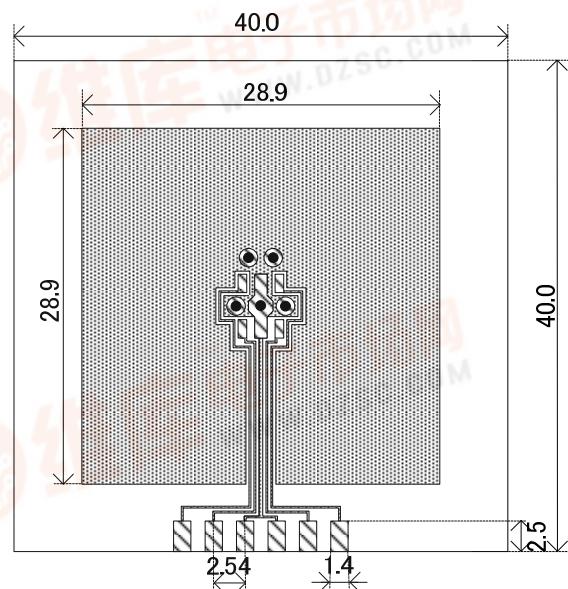
In top and back faces

Package heat-sink is tied to the copper traces

Material: Glass Epoxy (FR-4)

Thickness: 1.6 mm

Through-hole: 5 x 0.8 Diameter

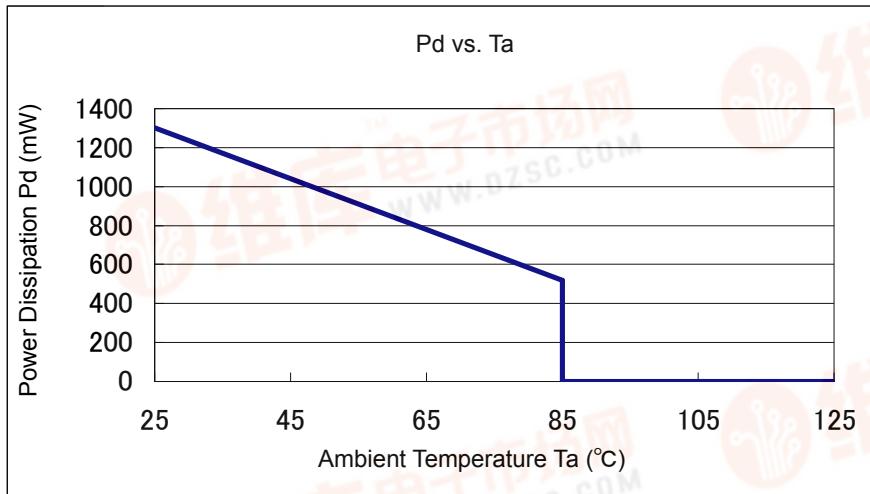


Evaluation Board (Unit: mm)

2. Power Dissipation vs. Operating temperature

Board Mount (T_j max = 125°C)

Ambient Temperature (°C)	Power Dissipation P_d (mW)	Thermal Resistance (°C/W)
25	1300	76.92
85	520	



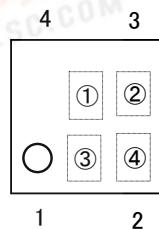
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■ MARKING RULE

● USPQ-4B03

① represents type of regulator and output voltage range.

MARK		H	PRODUCT SERIES	
OUTPUT VOLTAGE 0.1V INCREMENTS				
VOLTAGE=1.2~3.9V			VOLTAGE =1.25~3.95V	
0			8 XC6223A*****	
1			9 XC6223B*****	
2			A XC6223C*****	
3			B XC6223D*****	
4			C XC6223E*****	
5			D XC6223F*****	
6			E XC6223G*****	
7			F XC6223H*****	



USPQ-4B03
(TOP VIEW)

② represents output voltage.

VOLTAGE=1.2~3.95[V]

MARK	OUTPUT VOLTAGE (V)	MARK	OUTPUT VOLTAGE (V)
0	-	-	F 2.50 2.55
1	-	-	H 2.60 2.65
2	1.20	1.25	K 2.70 2.75
3	1.30	1.35	L 2.80 2.85
4	1.40	1.45	M 2.90 2.95
5	1.50	1.55	N 3.00 3.05
6	1.60	1.65	P 3.10 3.15
7	1.70	1.75	R 3.20 3.25
8	1.80	1.85	S 3.30 3.35
9	1.90	1.95	T 3.40 3.45
A	2.00	2.05	U 3.50 3.55
B	2.10	2.15	V 3.60 3.65
C	2.20	2.25	X 3.70 3.75
D	2.30	2.35	Y 3.80 3.85
E	2.40	2.45	Z 3.90 3.95

VOLTAGE=4.0[V]

PRODUCT SERIES	MARK
XC6223A*****	0
XC6223B*****	1
XC6223C*****	2
XC6223D*****	3
XC6223E*****	4
XC6223F*****	5
XC6223G*****	6
XC6223H*****	7

③④ represents production lot number.

01 to 09, 0A to 0Z, 11 to 9Z, A1 to A9, AA to Z9, ZA to ZZ in order.

(G, I, J, O, Q, W excepted)

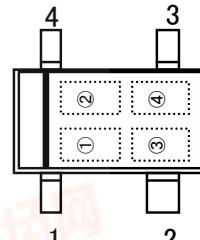
*No character inversion used.

■ MARKING RULE (Continued)

● SSOT-24 (with bar)

① represents type of regulator and output voltage range.

MARK			PRODUCT SERIES
OUTPUT VOLTAGE 0.1V INCREMENTS		OUTPUT VOLTAGE 0.05V INCREMENTS	
VOLTAGE =1.2~2.9V	VOLTAGE =3.0~4.0V	VOLTAGE =1.25~3.95V	
B	3	8	XC6223A*****
C	5	9	XC6223B*****
D	7	S	XC6223C*****
E	A	T	XC6223D*****
K	F	U	XC6223E*****
L	H	V	XC6223F*****
M	P	X	XC6223G*****
N	Z	Y	XC6223H*****



SSOT-24(with bar)
(TOP VIEW)

② represents output voltage.

MARK	OUTPUT VOLTAGE (V)				MARK	OUTPUT VOLTAGE (V)			
0	-	-	-	-	F	2.50	3.20	-	2.55
1	-	-	-	-	H	2.60	3.30	-	2.65
2	1.20	-	-	1.25	K	2.70	3.40	-	2.75
3	1.30	-	-	1.35	L	2.80	3.50	-	2.85
4	1.40	-	-	1.45	M	2.90	3.60	-	2.95
5	1.50	-	-	1.55	N	-	-	-	3.05
6	1.60	-	-	1.65	P	-	3.70	-	3.15
7	1.70	-	-	1.75	R	-	3.80	-	3.25
8	1.80	-	-	1.85	S	-	3.90	-	3.35
9	1.90	-	-	1.95	T	-	4.00	-	3.45
A	2.00	-	-	2.05	U	-	-	-	3.55
B	2.10	-	-	2.15	V	-	-	-	3.65
C	2.20	-	-	2.25	X	-	-	-	3.75
D	2.30	3.00	-	2.35	Y	-	-	-	3.85
E	2.40	3.10	-	2.45	Z	-	-	-	3.95

③④ represents production lot number.

01 to 09, 0A to 0Z, 11 to 9Z, A1 to A9, AA to Z9, ZA to ZZ in order.

(G, I, J, O, Q, W excepted)

*No character inversion used.

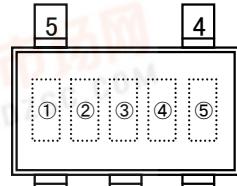
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■ MARKING RULE (Continued)

● SOT-25, SOT-89-5, USP-4

① represents product series

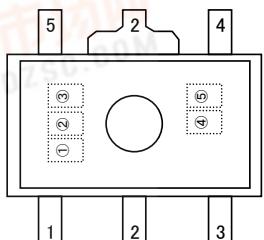
MARK	PRODUCT SERIES
9	XC6223*****



SOT-25
(TOP VIEW)

② represents type of regulator.

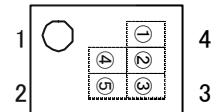
MARK			PRODUCT SERIES
OUTPUT VOLTAGE 0.1V INCREMENTS		OUTPUT VOLTAGE 0.05V INCREMENTS	
VOLTAGE =1.2~3.9V	VOLTAGE =4.0V	VOLTAGE =1.25~3.95V	
C	D	E	XC6223A*****
F	H	K	XC6223B*****
L	M	N	XC6223C*****
P	R	S	XC6223D*****
T	U	V	XC6223E*****
X	Y	Z	XC6223F*****
0	1	2	XC6223G*****
3	4	5	XC6223H*****



SOT-89-5
(TOP VIEW)

③ represents output voltage.

MARK	OUTPUT VOLTAGE (V)		MARK	OUTPUT VOLTAGE (V)	
0	-	4.00	-	2.50	-
1	-	-	-	2.60	-
2	1.20	-	1.25	-	2.70
3	1.30	-	1.35	-	2.80
4	1.40	-	1.45	-	2.90
5	1.50	-	1.55	-	3.00
6	1.60	-	1.65	-	3.10
7	1.70	-	1.75	-	3.20
8	1.80	-	1.85	-	3.30
9	1.90	-	1.95	-	3.40
A	2.00	-	2.05	-	3.50
B	2.10	-	2.15	-	3.60
C	2.20	-	2.25	-	3.70
D	2.30	-	2.35	-	3.80
E	2.40	-	2.45	-	3.90
			Z	-	3.95



USP-4
(TOP VIEW)

④⑤ represents production lot number.

01 to 09, 0A to 0Z, 11 to 9Z, A1 to A9, AA to Z9, ZA to ZZ in order.

(G, I, J, O, Q, W excepted)

*No character inversion used.

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